

Cryogenic operation of neutron-irradiated SiPM arrays from FBK and Hamamatsu

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6th International Workshop on new Photon-Detectors (PD24)

19 – 21 November 2024, Vancouver



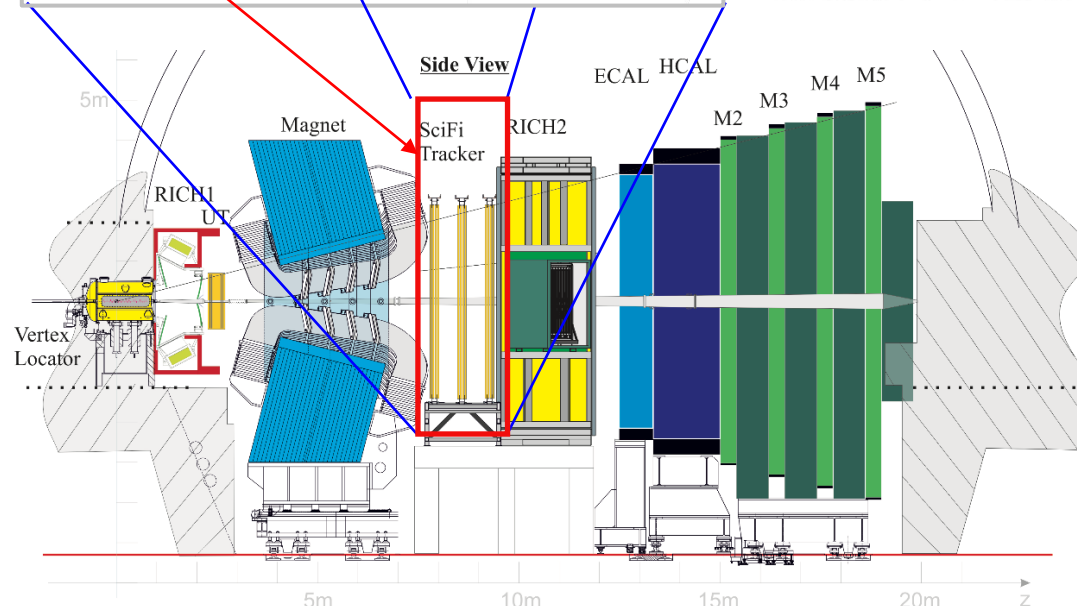
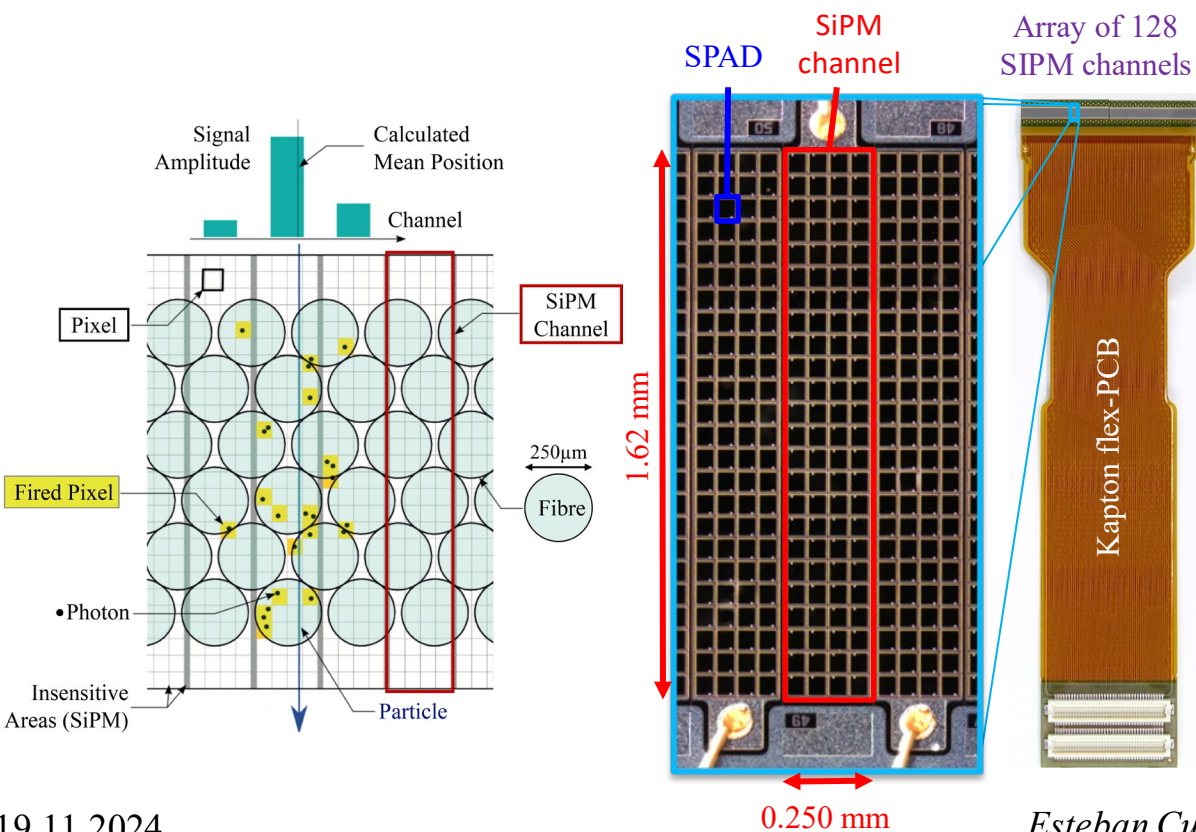
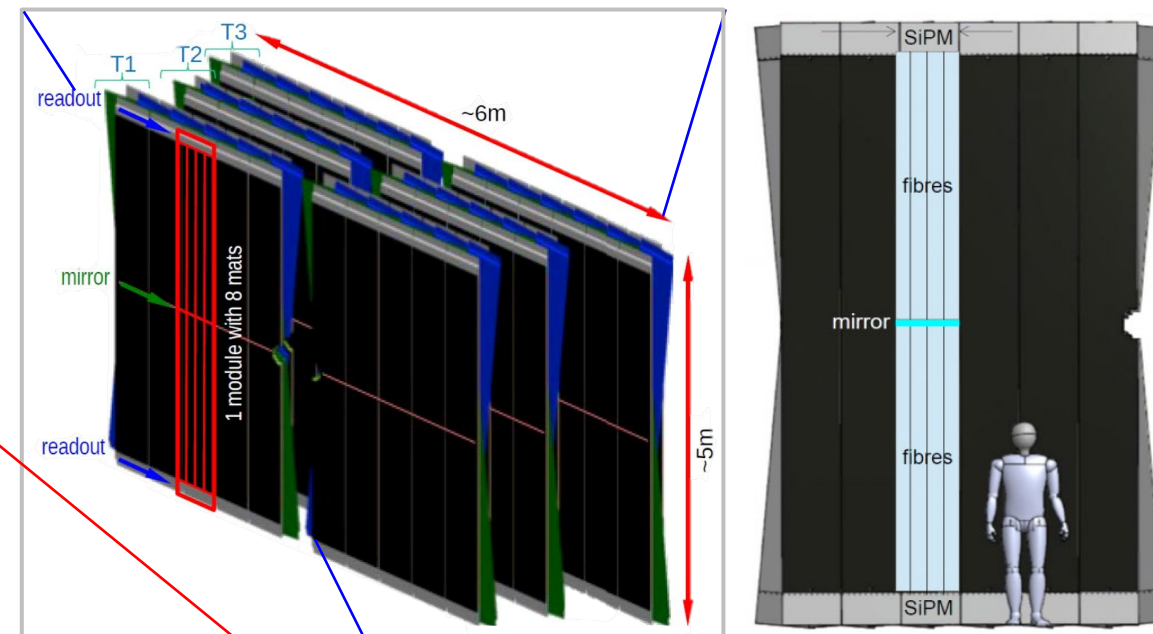
Outlook

- Introduction and motivation
- Silicon PhotoMultiplier (SiPM) modules under study and neutron irradiation
- Measurement in the cryostat setup
 - › Breakdown voltage (V_{bd}) → irradiated
 - › Quenching resistor (R_q) and recovery time (T_r) → unirradiated
 - › Photo Detection Efficiency (PDE) → unirradiated
 - › Gain (G) and Direct Crosstalk Probability (DCP) → unirradiated
 - › Dark Count Rate (DCR) based on dark current measurements → irradiated
 - › Signal correlated noise (measured only at 100 K) → irradiated
 - › Annealing studies at high temperature (measured only at 100 K) → irradiated
- Summary and conclusions

LHCb upgrade I (2019-2021)

The new SciFi detector

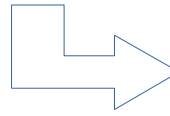
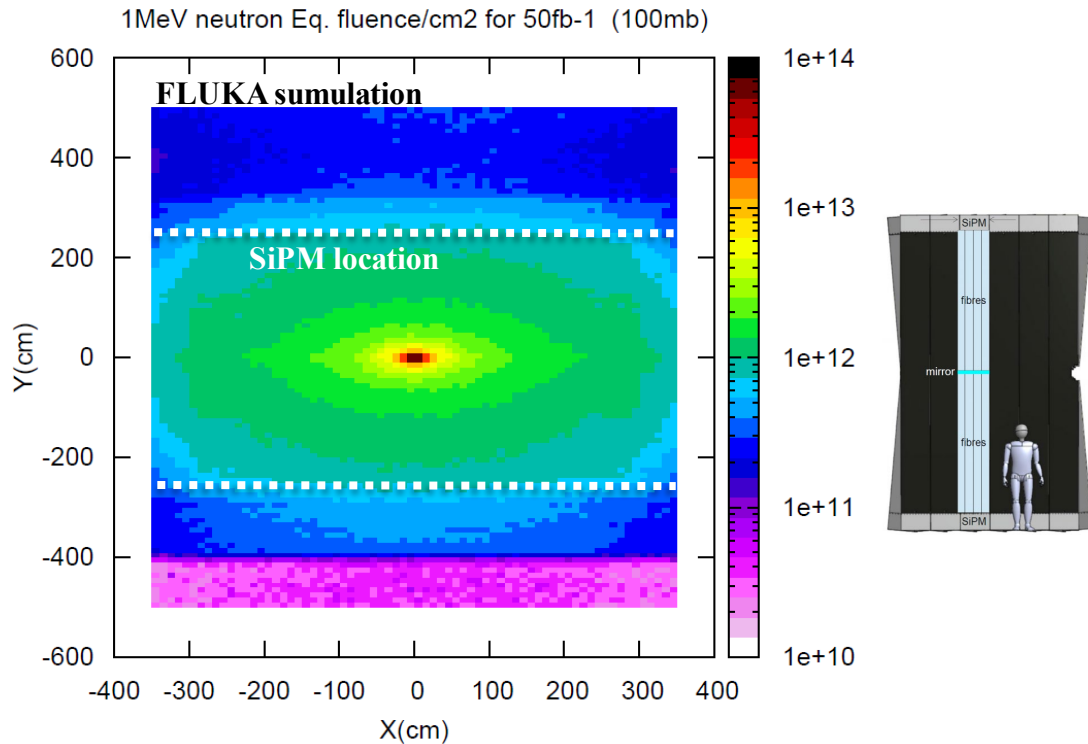
- Scintillating Fibre Tracker is installed in the tracking stations located downstream of the LHCb dipole magnet (highlighted in red)
- The scintillation light is recorded with arrays of multi-channel SiPMs



LHCb experiment upgrade (side view)

SiPM challenges for the LHCb Upgrade II (2033)

- More challenging radiation environment
- Mainly dominated by **neutrons**:
 - Neutron radiation expected: $3 \times 10^{12} \text{ n}_{\text{eq}}/\text{cm}^2$ (5x Upgrade I)



Dark count rate per SiPM channel (DCR)

DCR (not irradiated): 0.04 MHz.

DCR is increasing with neutron radiation.

The SiPMs are positioned far from the beam center.

Neutron radiation expected: $6 \cdot 10^{11} \text{ n}_{\text{eq}}/\text{cm}^2$.

DCR ($6 \cdot 10^{11} \text{ n}_{\text{eq}}/\text{cm}^2$ @ RT): 550 MHz.

The DCR can be reduced by cooling the SiPM.

DCR ($6 \cdot 10^{11} \text{ n}_{\text{eq}}/\text{cm}^2$ @ -40 °C): 14 MHz.

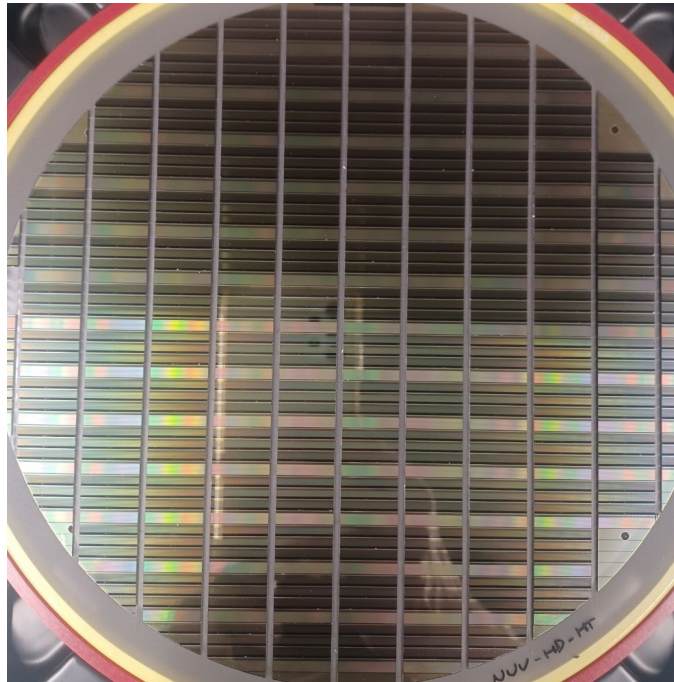
Learned from Upgrade I

Goal: cooling with liquid nitrogen at ~100 K

1st set of SiPM modules for the testing

Produced by **FBK** in 2022

Wafer layout



NUV-HD-MT

Wafer n.	Layout	Epi Thickness	DI energy	DI dose	Note	Note
1	EPFL	Thin	LF	D3	Cryo	Metal In Trench
4	EPFL	Thin	LF	D2	Cryo	Metal In Trench
7	EPFL	Thin	ULF	D3	Cryo	Metal In Trench
9	EPFL	Thin	ULF	D2	Cryo	Metal In Trench
11	EPFL	Thin	ULF	D1	Cryo	Metal In Trench

Gain ↑
↓

This study will focused on:

- FBK2022 modules of two different pixel size
 - 31.3x31.3 μm^2 (FBK 31 μm)
 - 41.7x41.7 μm^2 (FBK 42 μm)
- HPK2017 modules with a pixel size of → 62.0x57.0 μm^2 (H2017)

Irradiated with **neutrons** in Ljubljana (2023)

- 3×10^{11} n_{eq}/cm²
- 1×10^{12} n_{eq}/cm²
- **3×10^{12} n_{eq}/cm²** (nominal fluence)
- 1×10^{13} n_{eq}/cm²

After irradiation, a thermal **annealing of 2 weeks at 30°C** was performed

Cryogenic setup

Helium cryocooler
(25K up to RT)

Compressor

DAQ

Cryostat

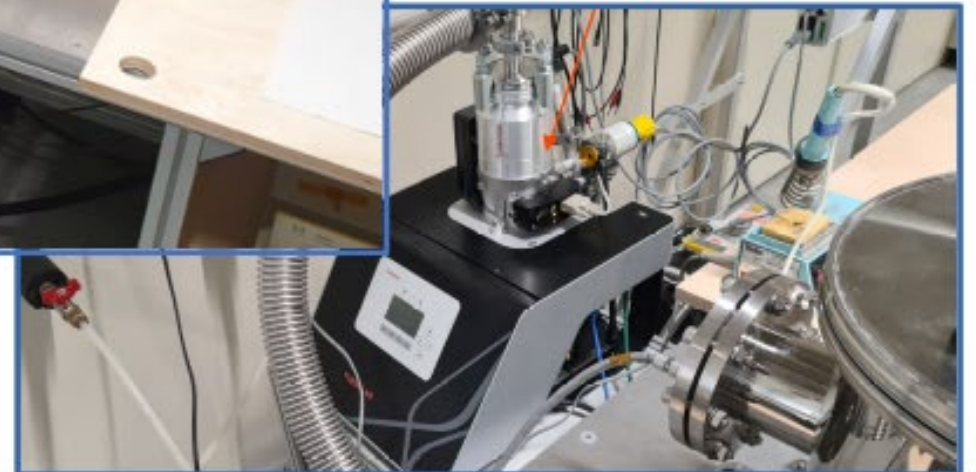
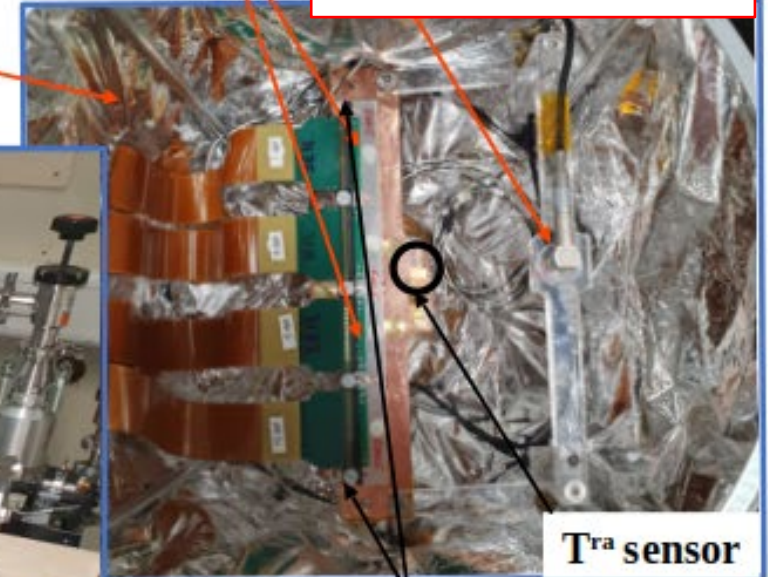
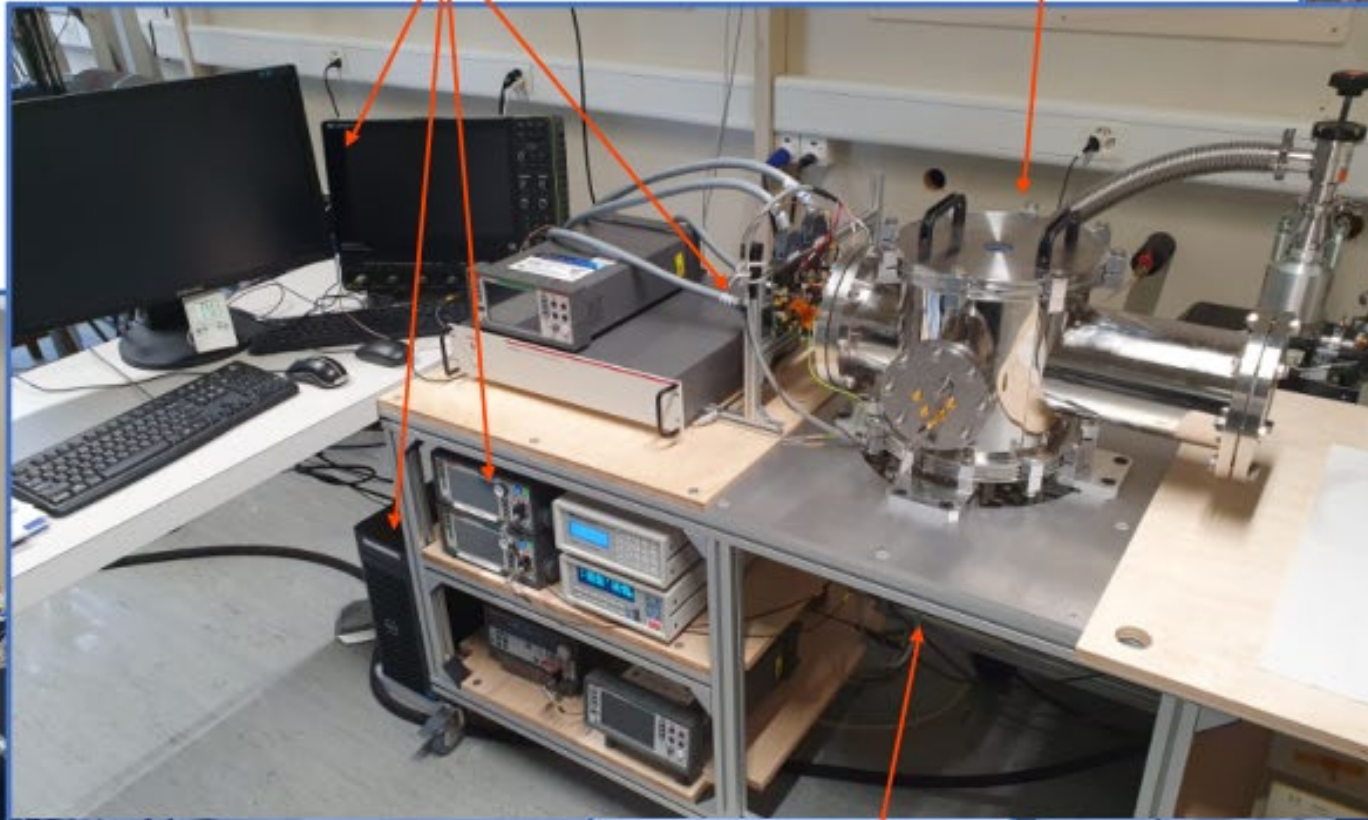
4 SiPM modules

Illumination source

T^{ra} sensor

50W heaters under the support
Pump for the vacuum

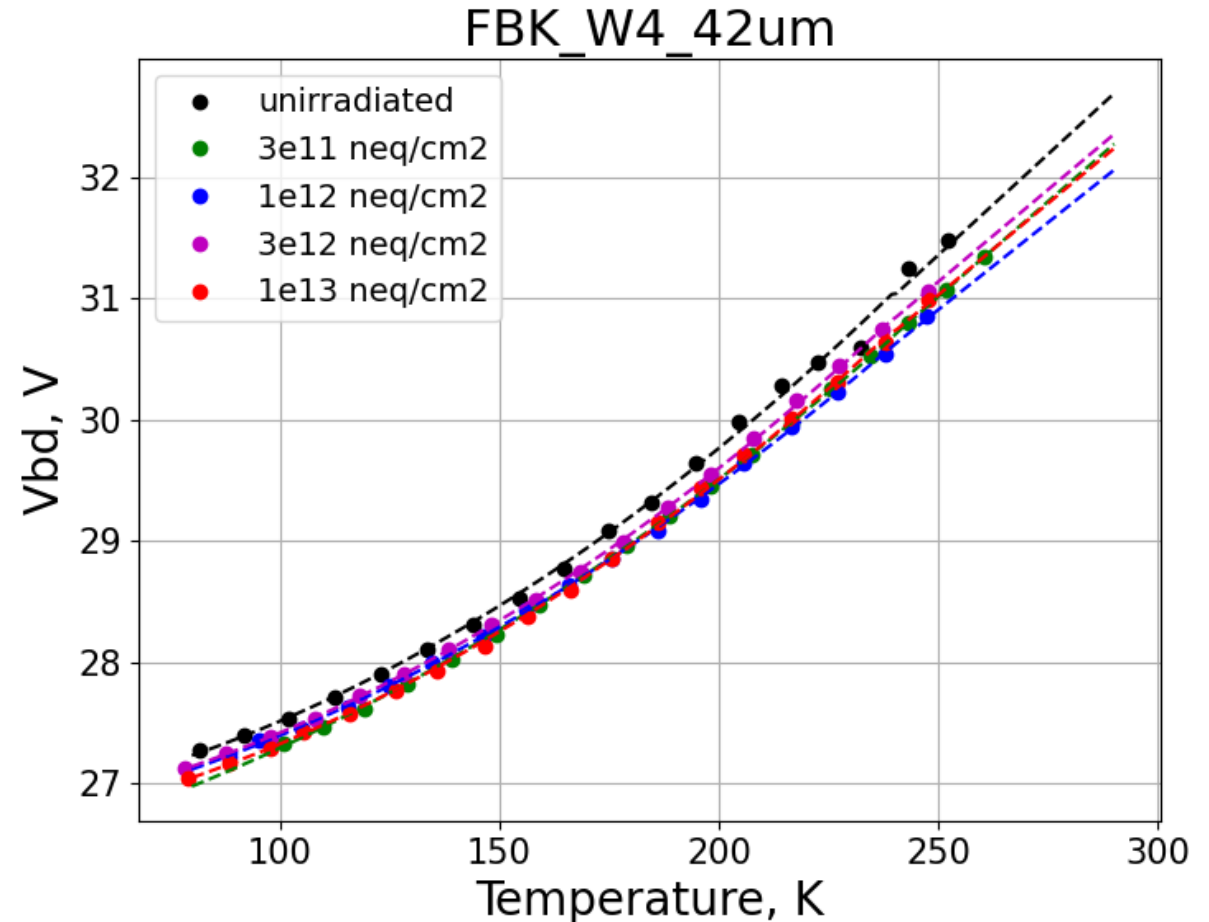
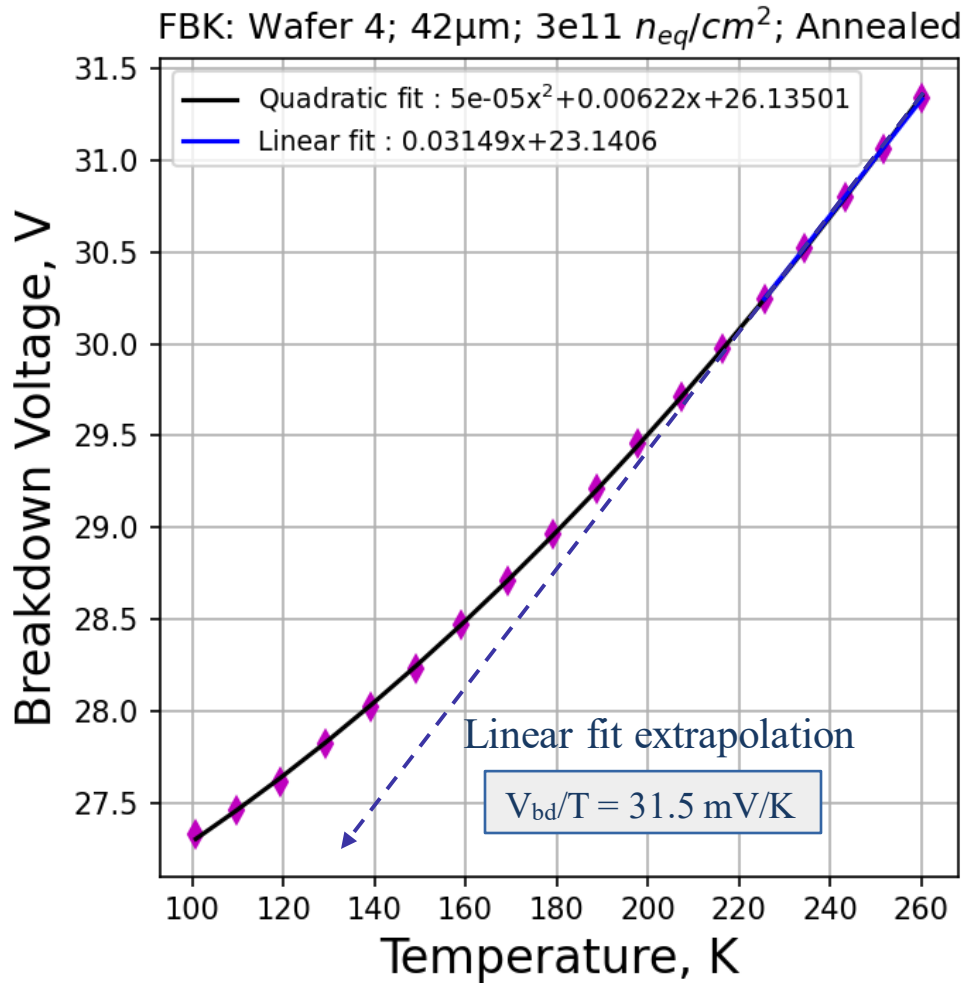
Expander
(Cryocooler)



FBK SiPMs: V_{bd} vs temperature

Breakdown voltage as a function of the temperature

We do not observe any variation with the irradiation fluence (dispersion between different modules $\sim 0.5V$)

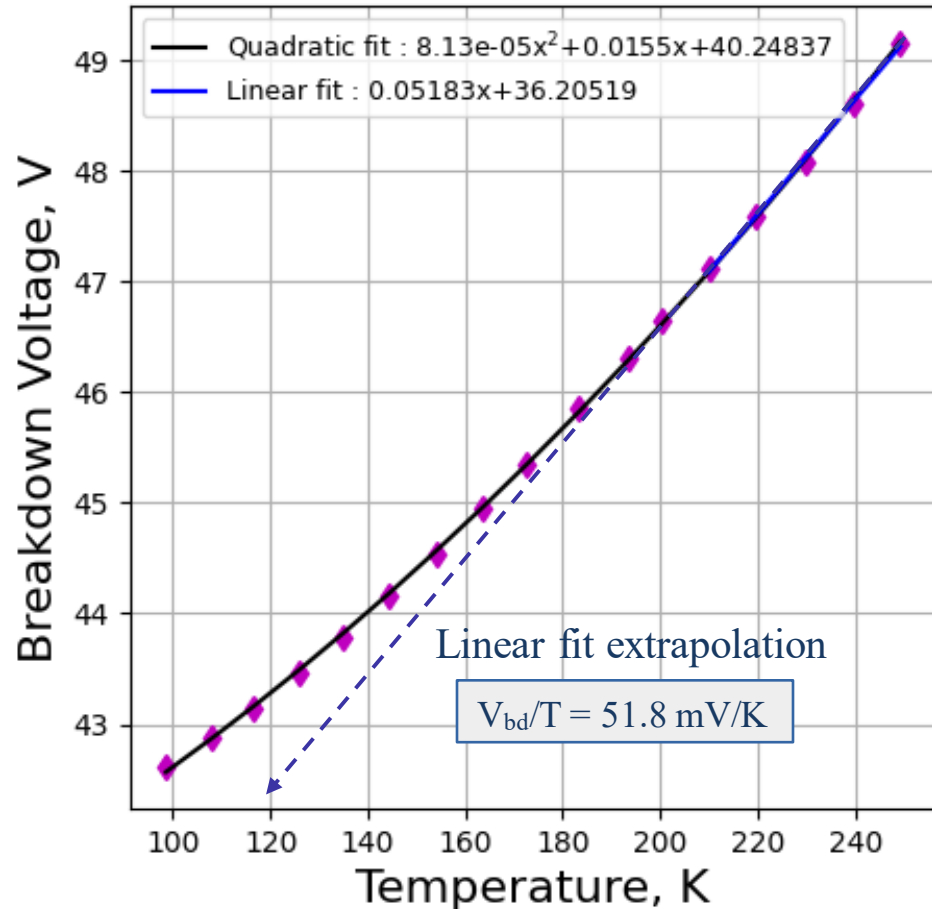


HPK SiPMs: V_{bd} vs temperature

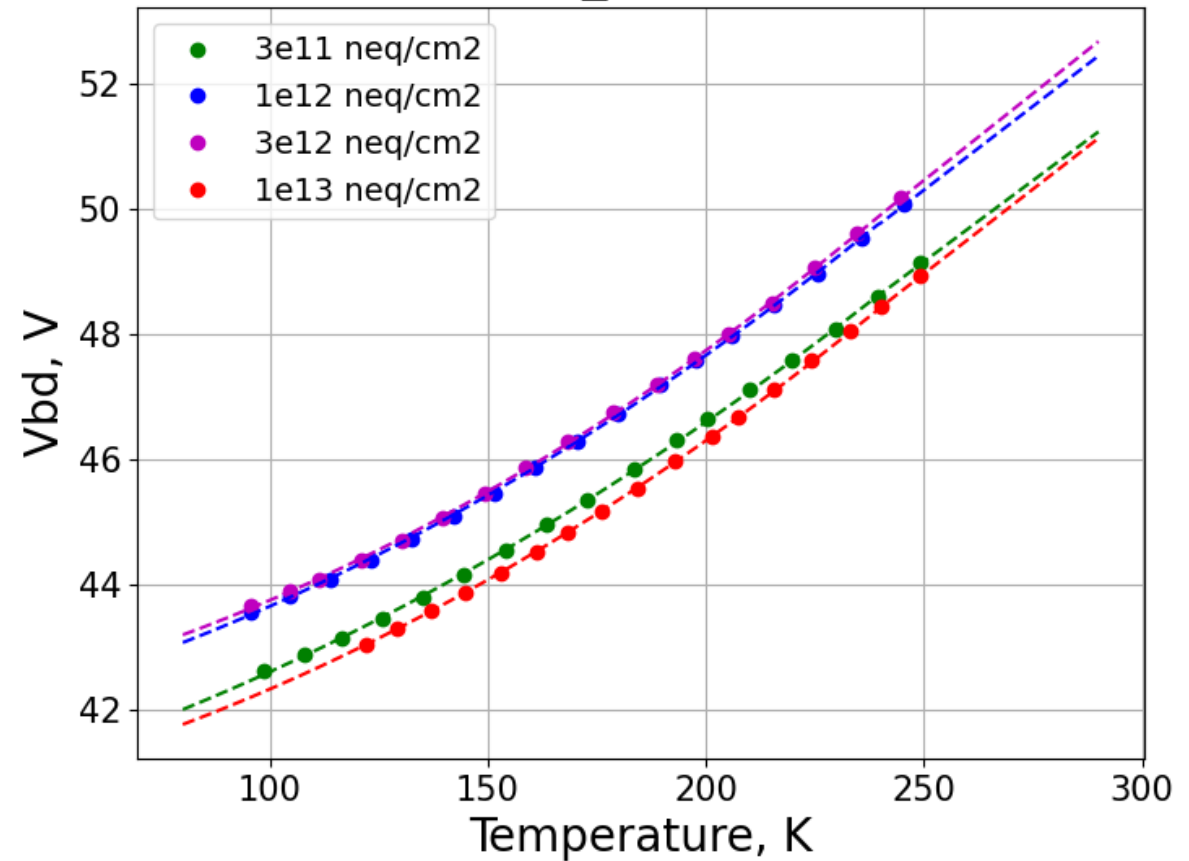
Breakdown voltage as a function of the temperature

We do not observe any variation with the irradiation fluence (bigger dispersion between different modules $\sim 1.0V$)

H2017: $3e11 \text{ neq/cm}^2$; Annealed

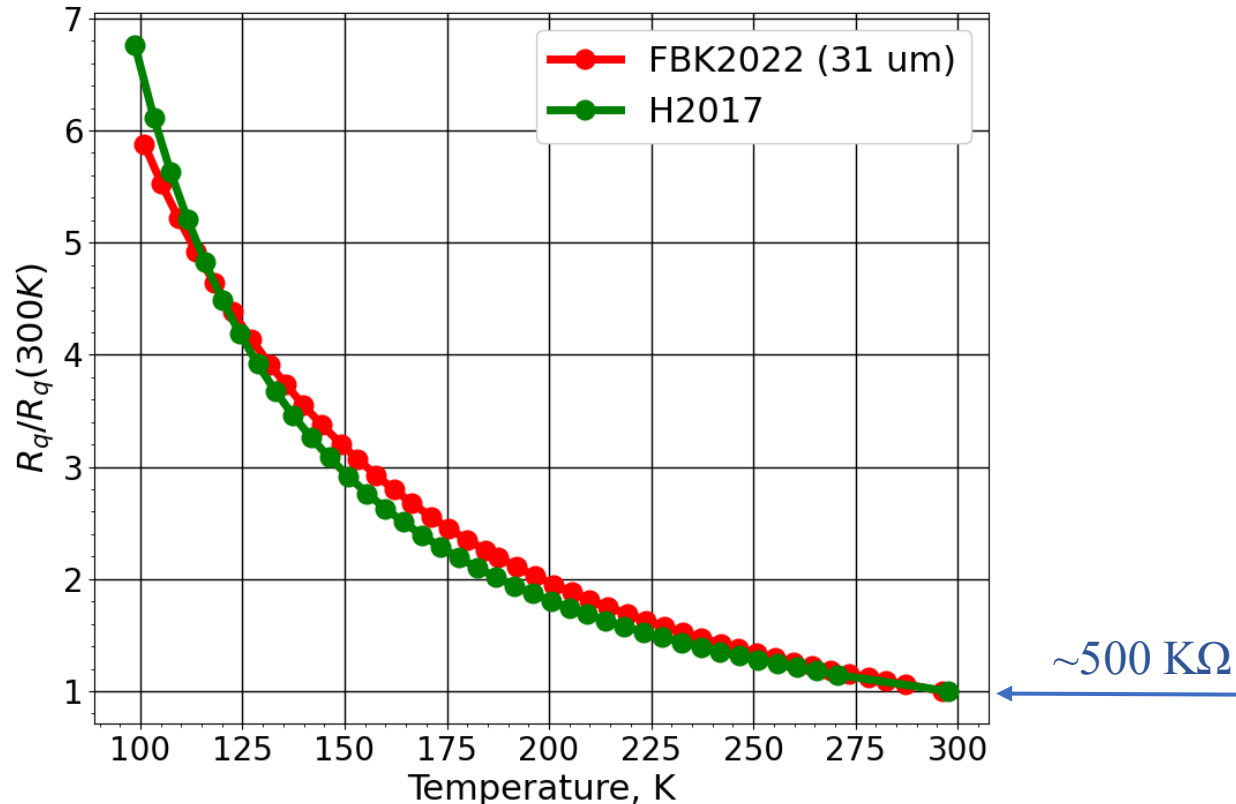


H2017_62x57 μm^2

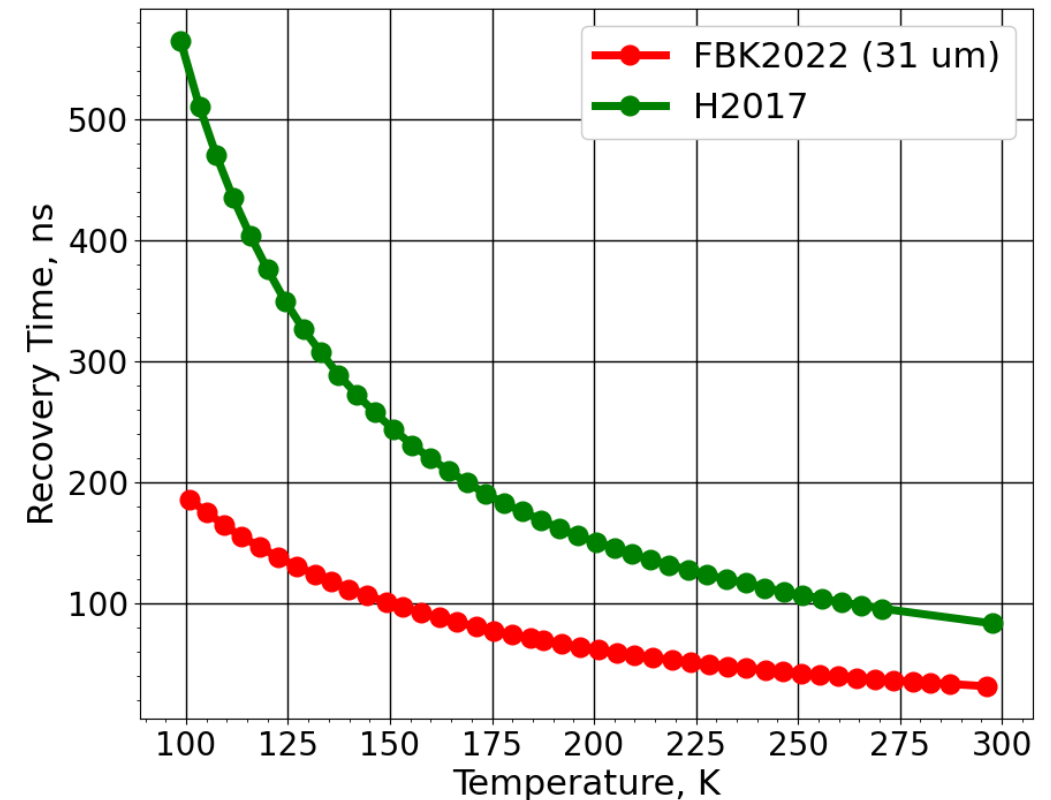


SiPMs: R_q & T_r vs temperature (unirradiated)

Quenching resistor vs temperature



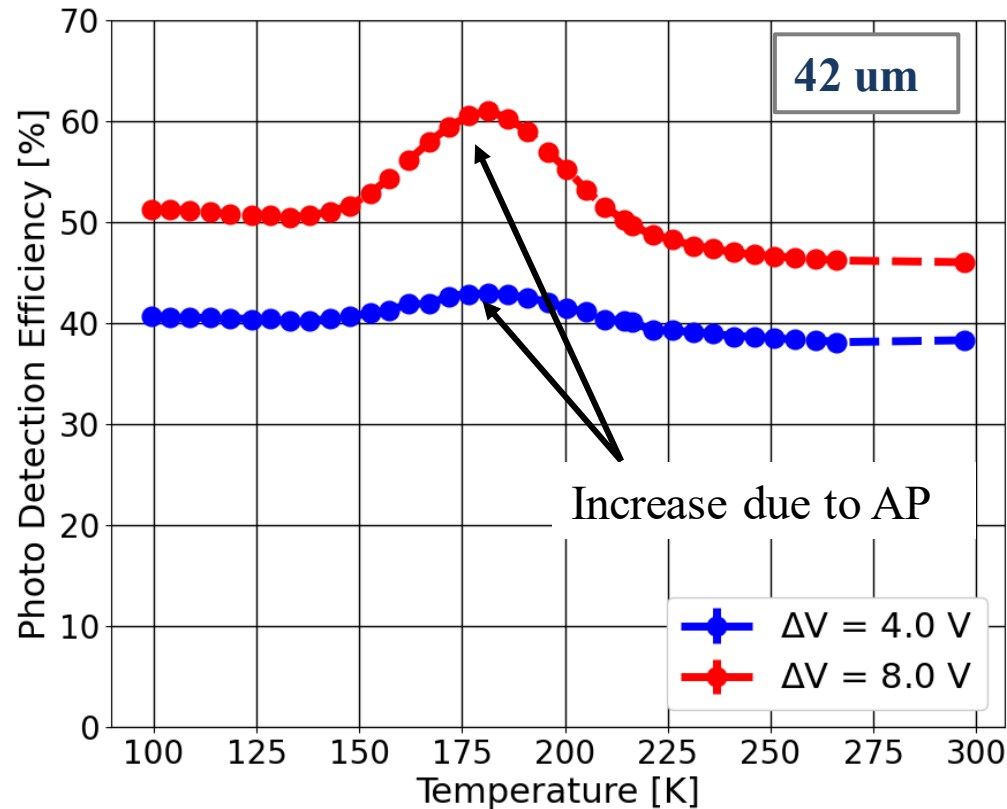
Recovery time vs temperature



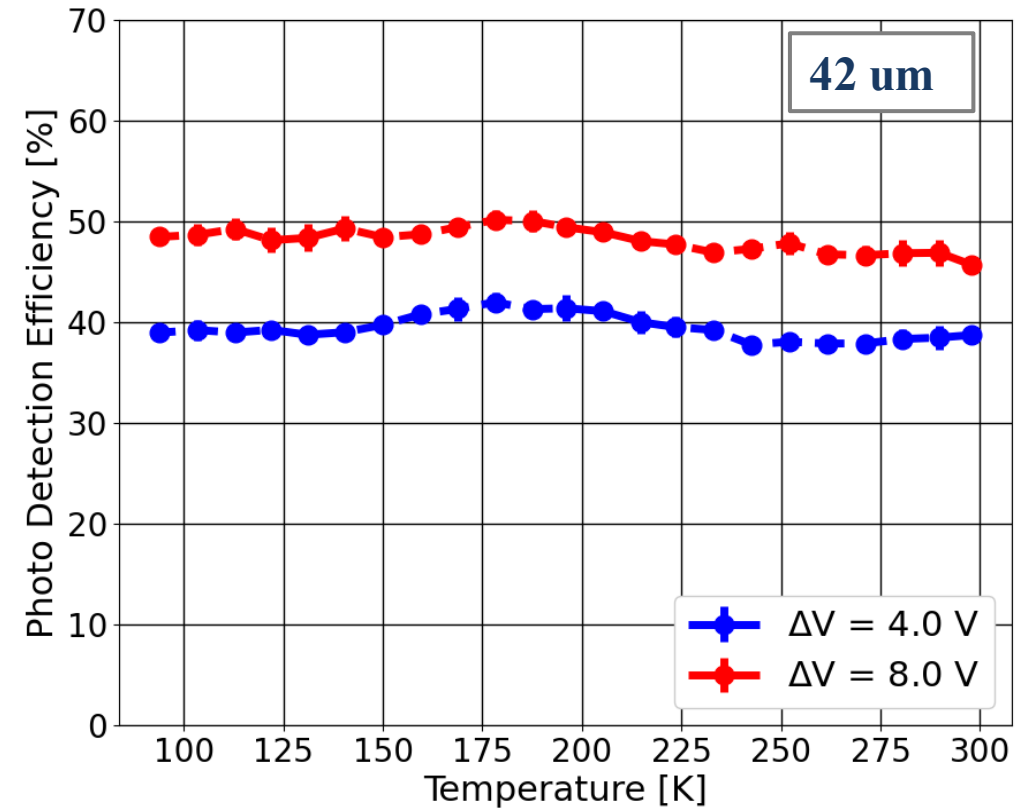
- The quenching resistor value at 100 K is a factor of 6-7 higher than at room temperature
- The target recovery time for the experiment should be around 200 ns:
 - Shorter recovery times are better to increase the detector efficiency
 - Longer recovery times are better to minimize the impact of AP

FBK SiPMs: PDE vs temperature (unirradiated)

Illumination: Monochromator ($\lambda = 450$ nm)



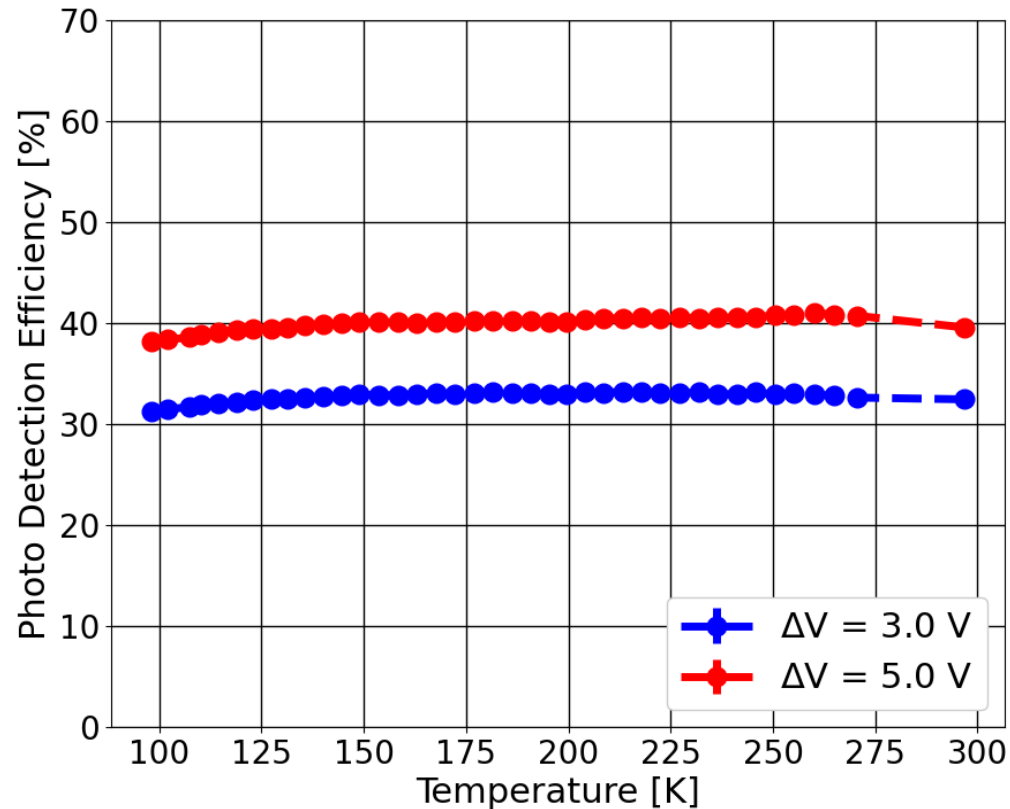
Illumination: Laser ($\lambda = 450$ nm)



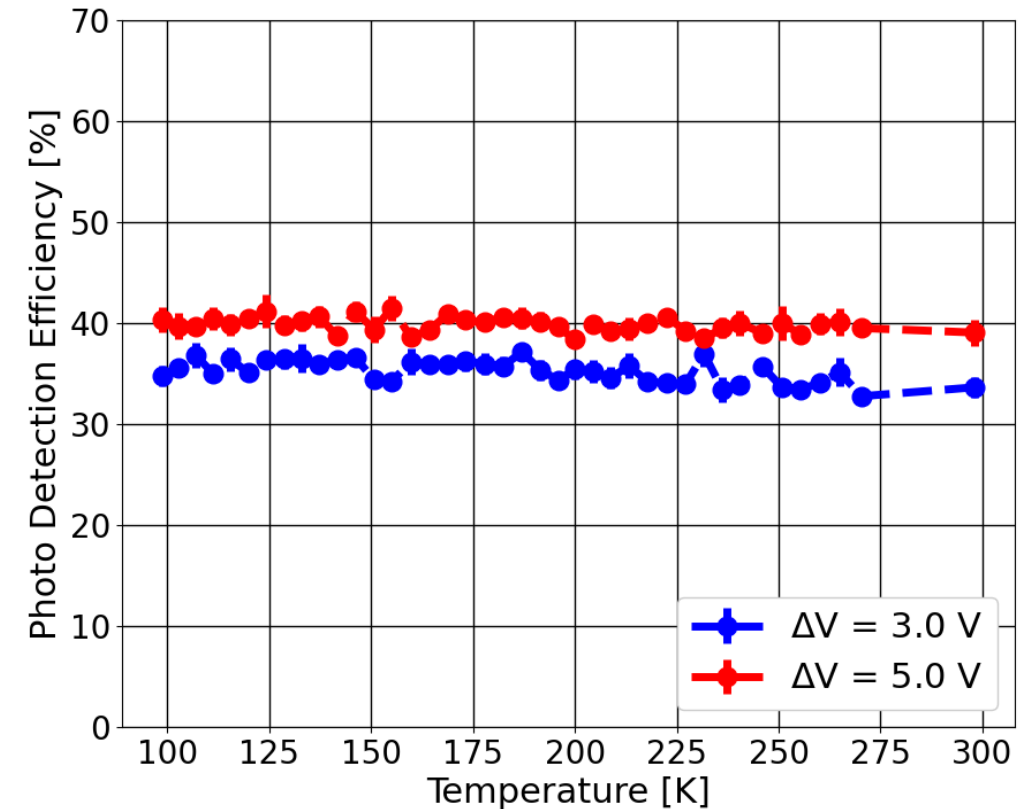
- The PDE does not change with temperature significantly
- Big presence of AP due to probably material impurities around 180 K
 - Monochromator: the AP noise is not filtered as there is not trigger signal
 - Laser: the AP noise is filtered, data taking is synchronize with the laser trigger

HPK SiPMs: PDE vs temperature (unirradiated)

Illumination: Monochromator ($\lambda = 450$ nm)



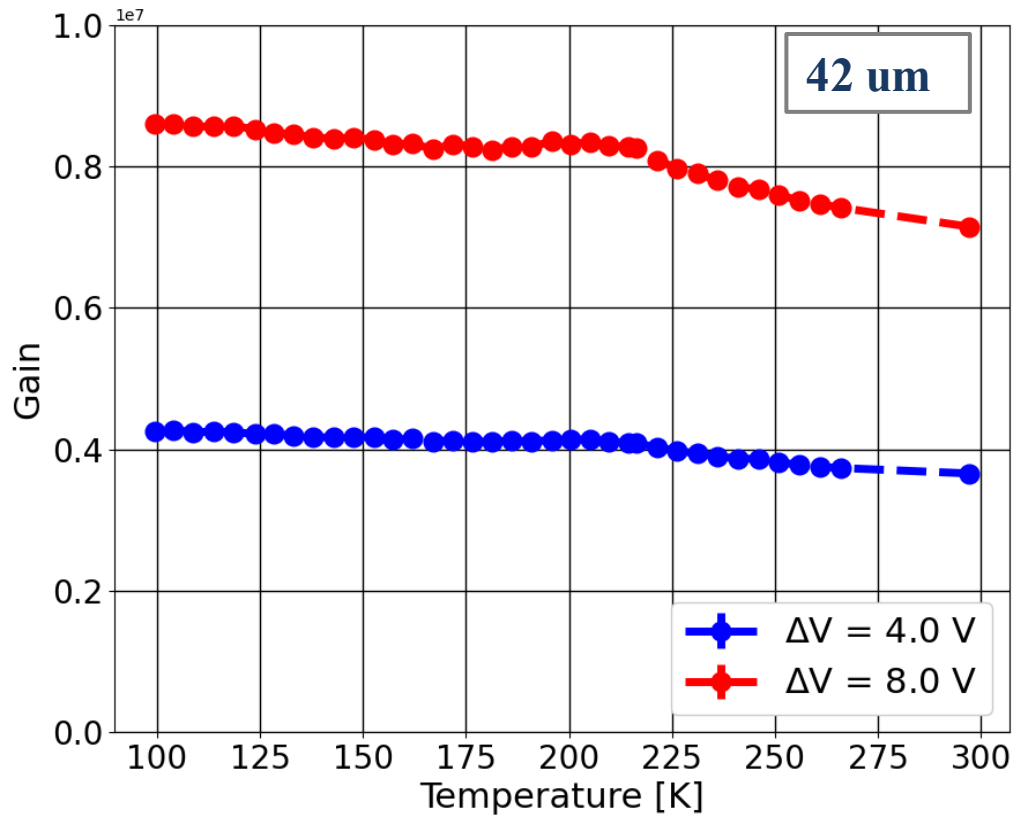
Illumination: Laser ($\lambda = 450$ nm)



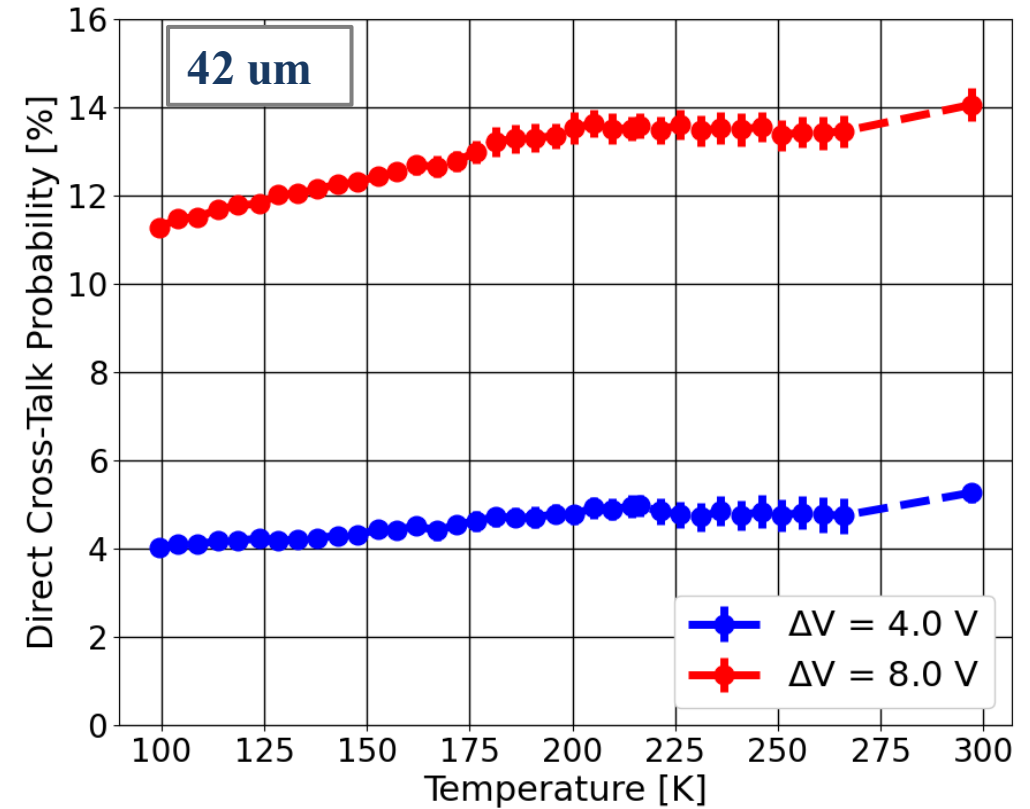
- The PDE does not change with temperature significantly
- No AP measured, less presence of impurities compared with FBK
 - Monochromator: the AP noise is not filtered as there is not trigger signal
 - Laser: the AP noise is filtered, data taking is synchronize with the laser trigger

FBK SiPMs: G & DCP vs temperature (unirradiated)

Illumination: Monochromator ($\lambda = 450$ nm)



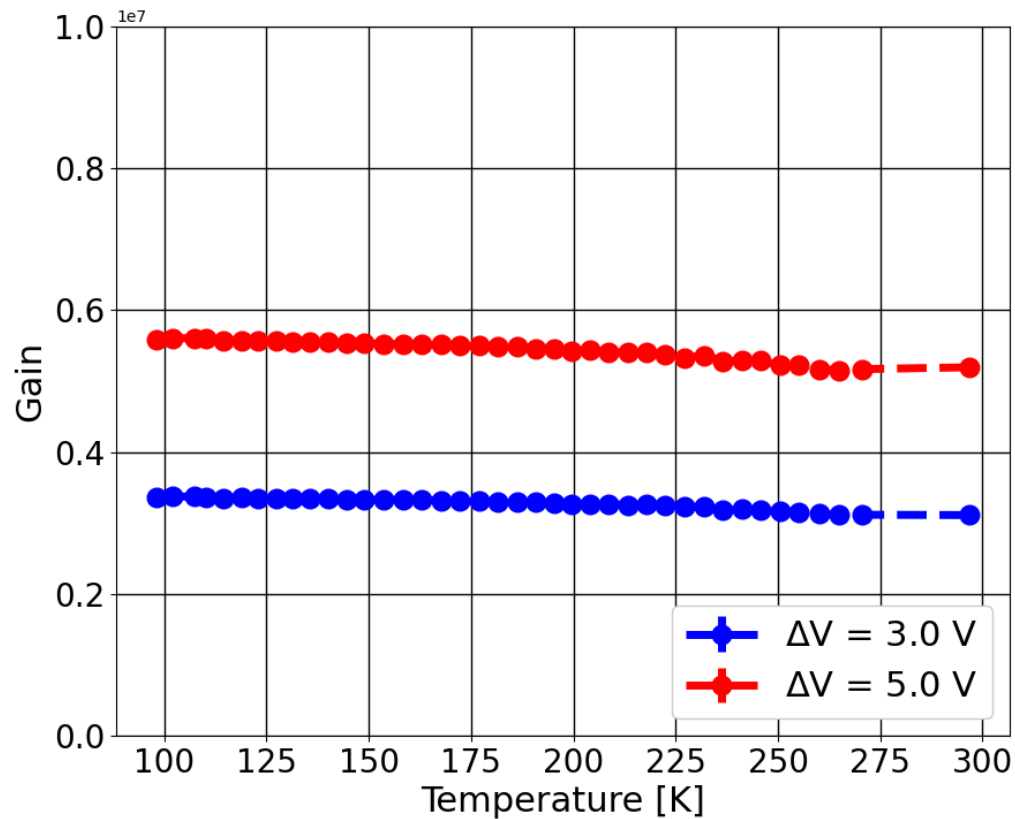
Illumination: Laser ($\lambda = 450$ nm)



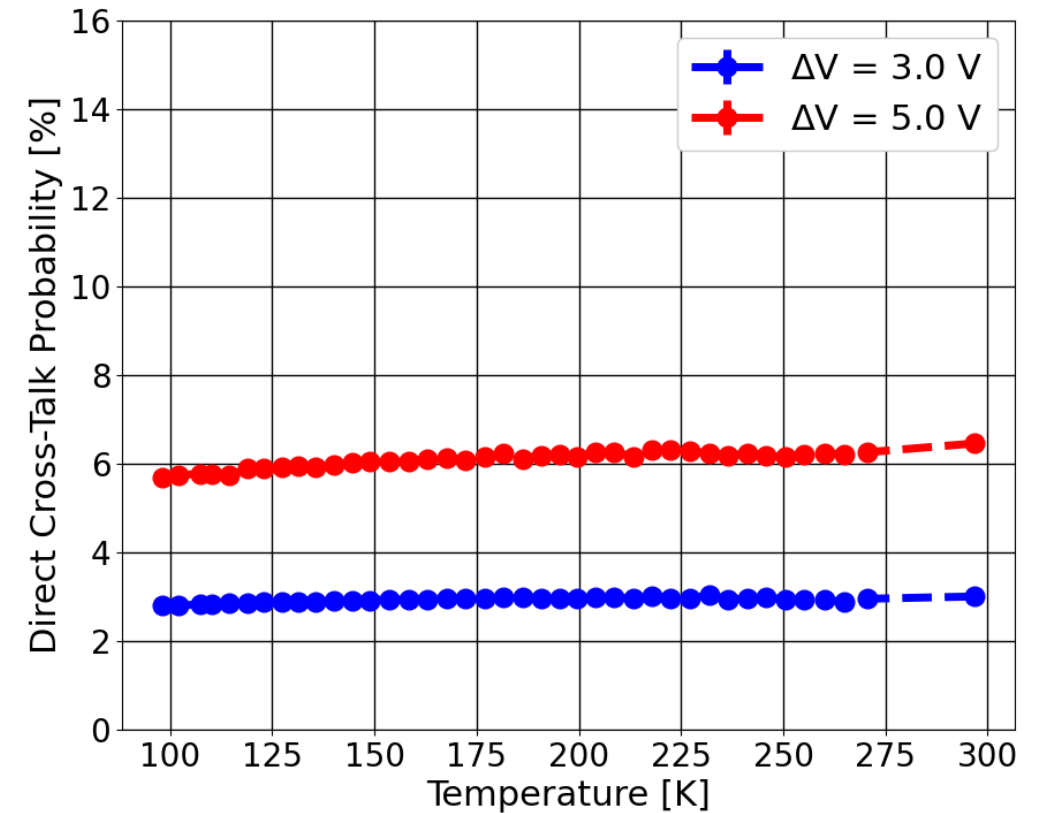
- The gain slightly increases with cooling
- The direct cross talk probability slightly decreases with cooling

HPK SiPMs: G & DCP vs temperature (unirradiated)

Illumination: Monochromator ($\lambda = 450$ nm)



Illumination: Laser ($\lambda = 450$ nm)

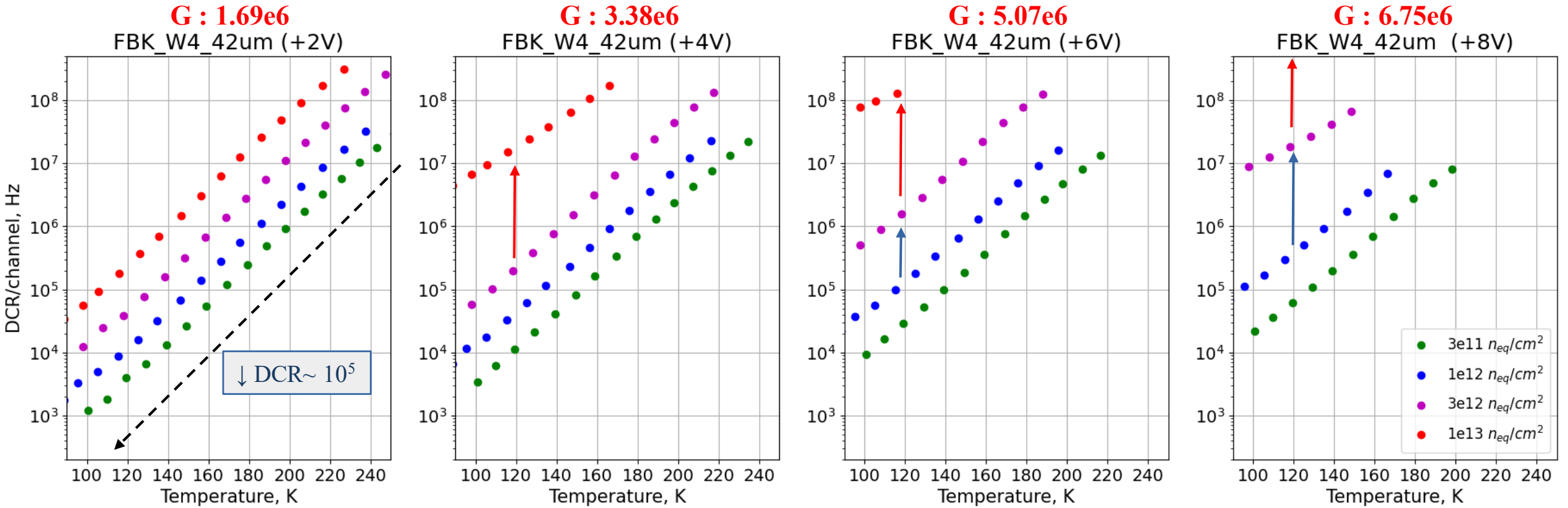


- The gain slightly increases with cooling
- The direct cross talk probability slightly decreases with cooling

FBK SiPM 42 um: DCR irradiated

$$DCR = \frac{I_{dark}}{e \times Gain}$$

DCR as a function of the temperature for different over-voltages:

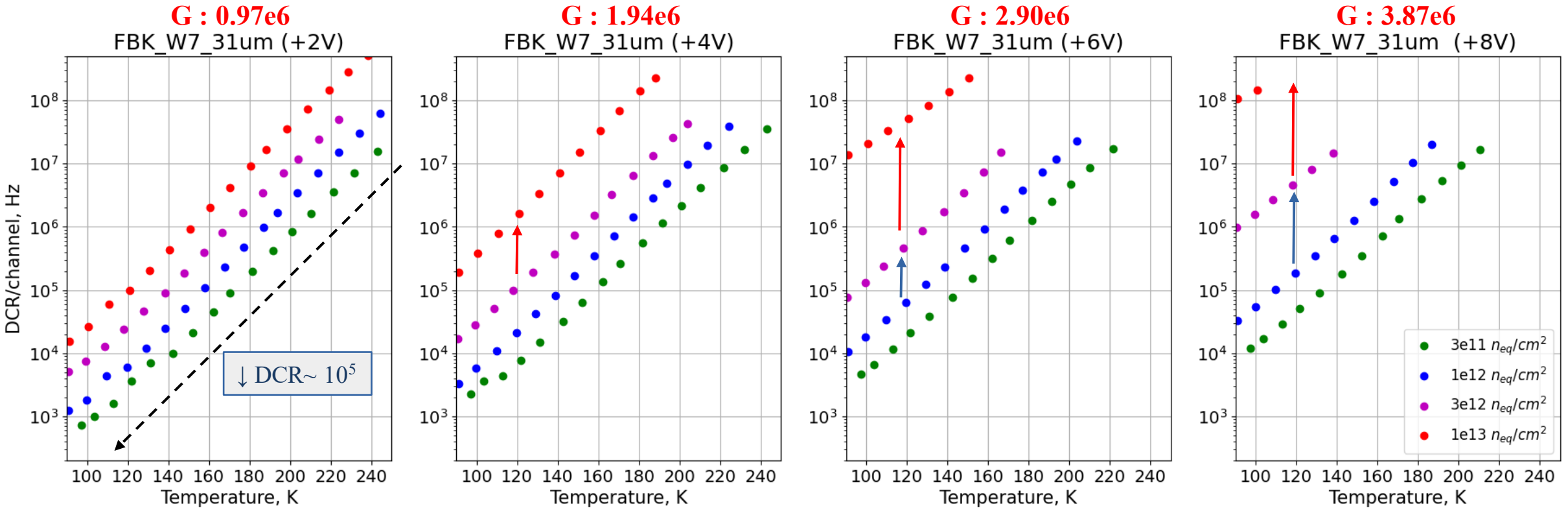


- DCR decreases with cooling, $\sim 10^5$ from room temperature down to 100K ($K_{1/2} = 10.1$ K slope)
- DCR increase proportional with fluence (NIEL hypothesis) only up to $\sim 1 \times 10^{12} n_{eq}/cm^2$

FBK SiPM 31 um: DCR irradiated

$$DCR = \frac{I_{dark}}{e \times Gain}$$

DCR as a function of the temperature for different over-voltages:

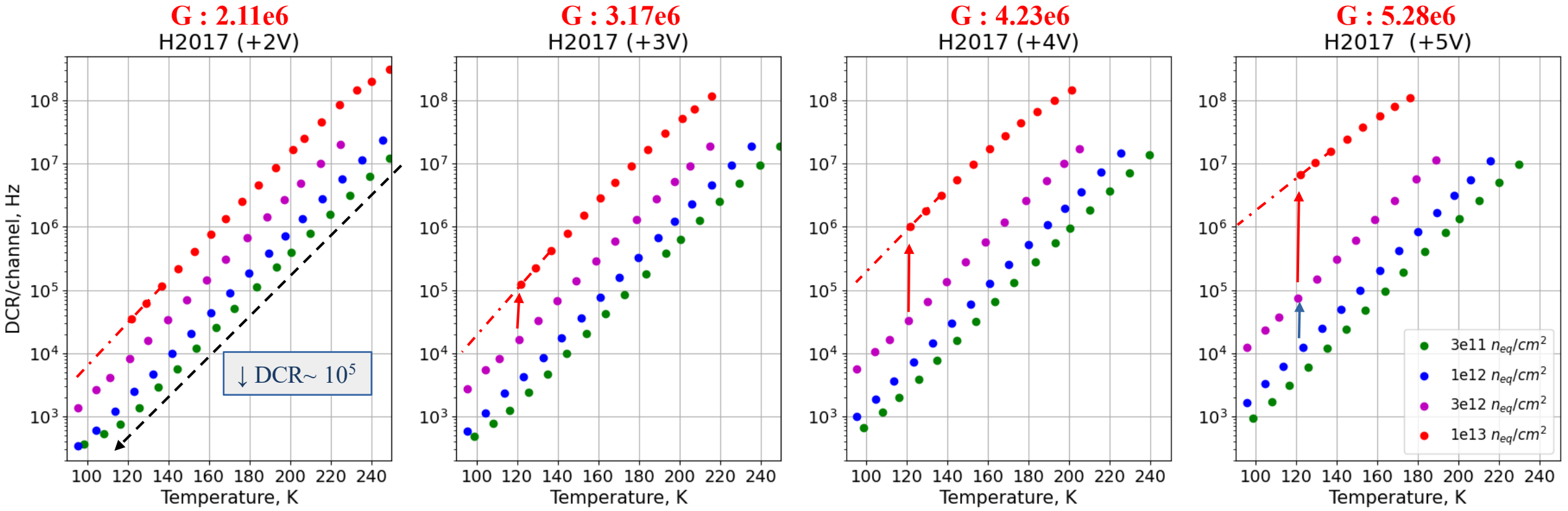


- Same as for 42μm pixel size but NIEL hypothesis valid up to $\sim 3 \times 10^{12} n_{eq}/cm^2$
- For the same over-voltage shows lower DCR (smaller pixel size == lower gain)

HPK SiPM: DCR irradiated

$$DCR = \frac{I_{dark}}{e \times Gain}$$

DCR as a function of the temperature for different over-voltages:



- DCR decreases with cooling, $\sim 10^5$ from room temperature down to 100K ($K_{1/2} = 10.1$ K slope)
- DCR increase proportional with fluence (NIEL hypothesis) only up to $\sim 1 \times 10^{13} n_{eq}/cm^2$

Note: values for the fluence of $1 \times 10^{13} n_{eq}/cm^2$ extrapolated down to 100K (last measured point at 120 K)

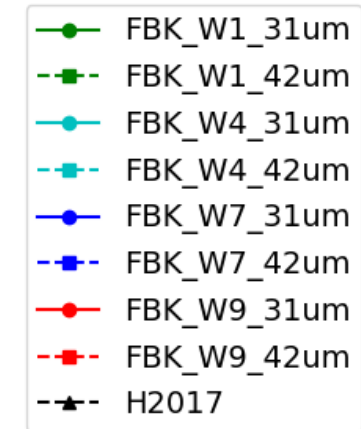
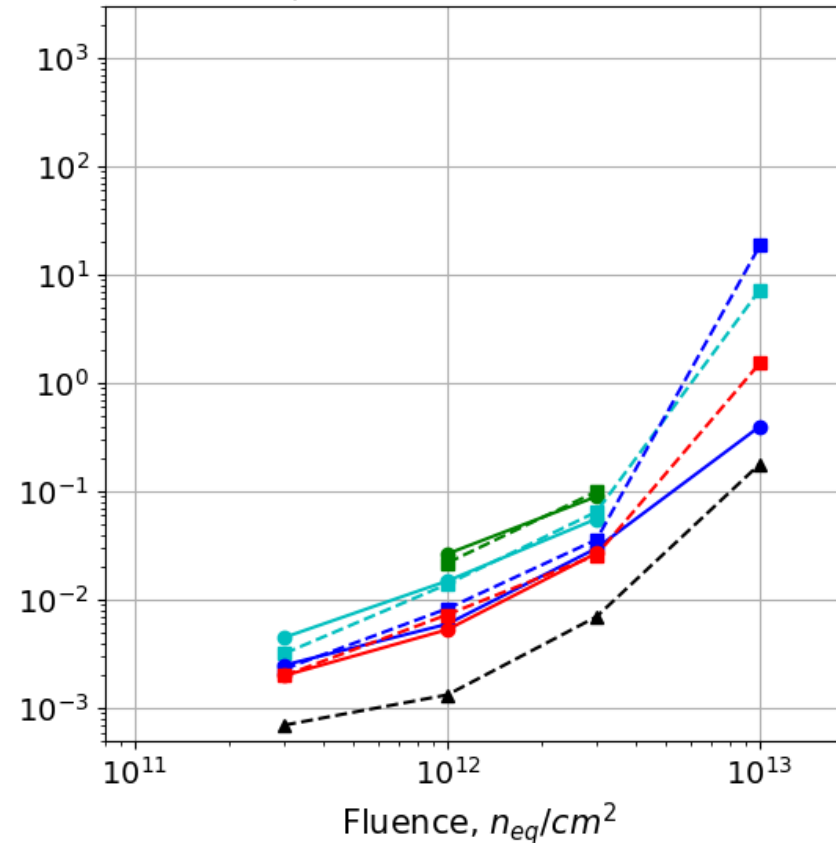
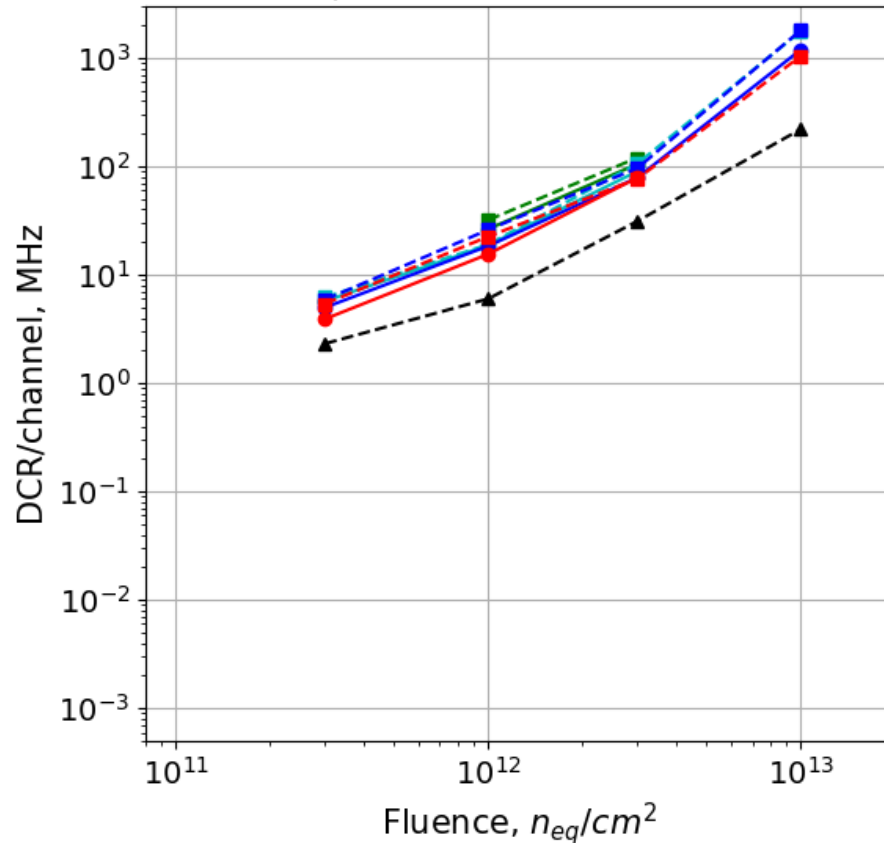
Comparison all SiPMs: DCR vs fluence

LHCb Upgrade I

LHCb Upgrade II

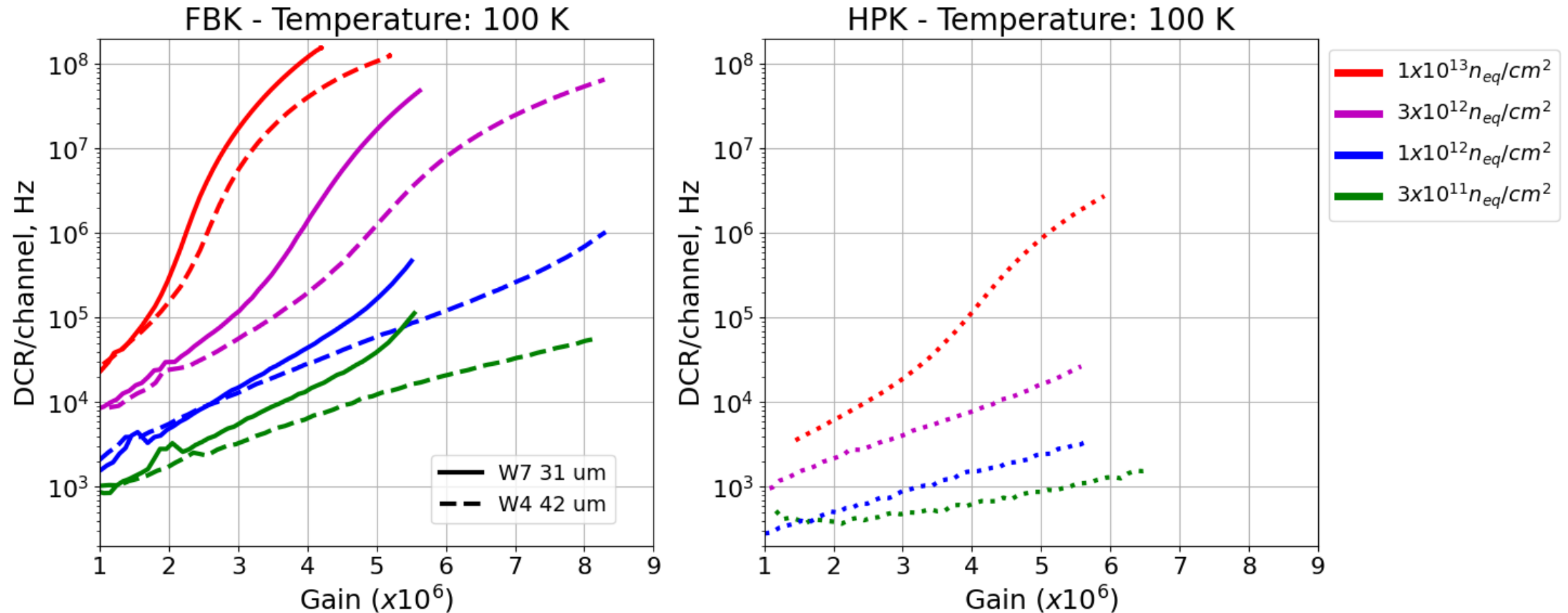
Temperature: 210 K, $\Delta V = 4$ V

Temperature: 100 K, $\Delta V = 4$ V



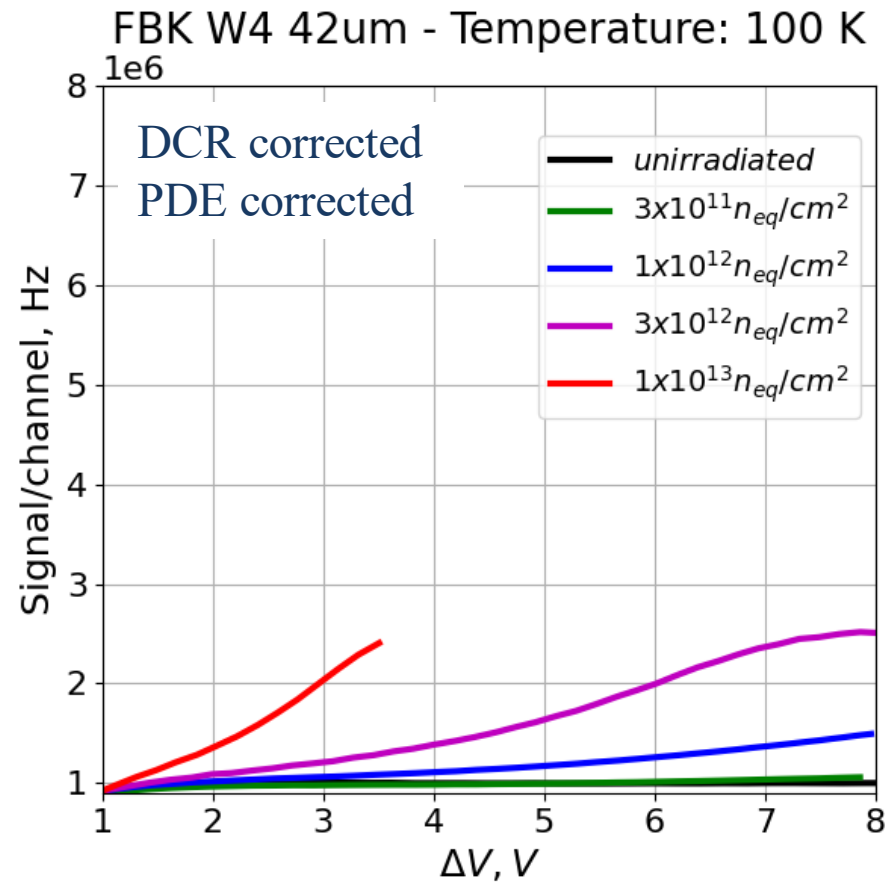
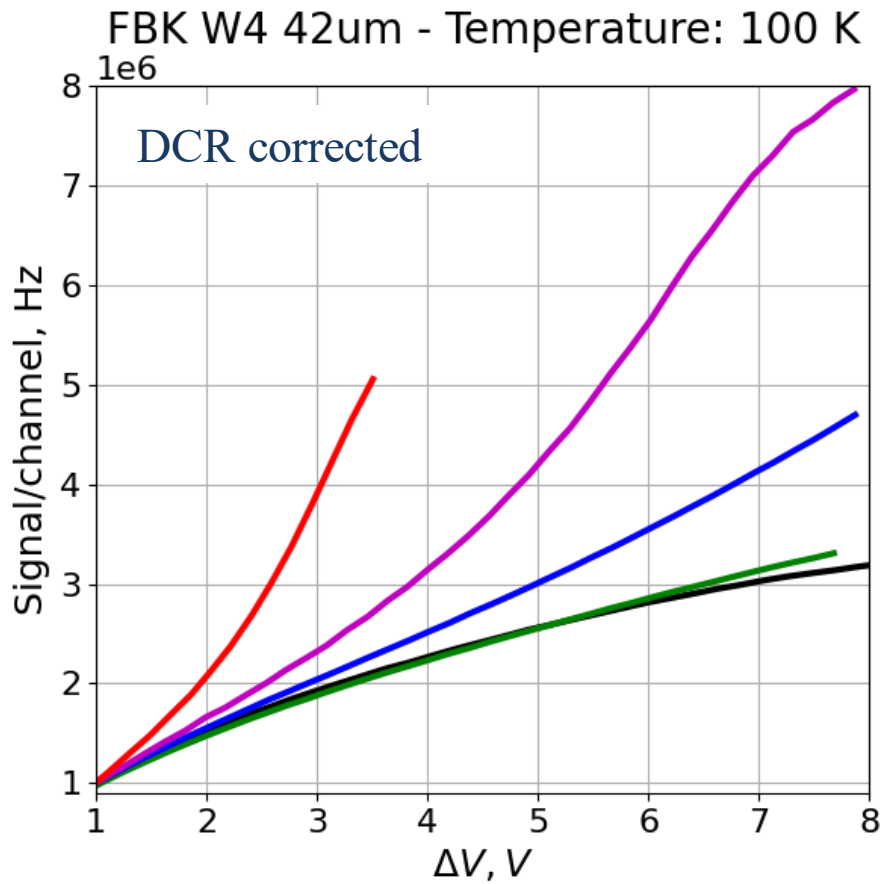
- Best FBK performance in terms of DCR is W9_31um (lower gain), while the worse is W1_42um (highest gain)
- H2017 has lower DCR than the latest technology from FBK but also large increase above $3 \times 10^{12} n_{eq}/cm^2$
- Smaller pixels can be operated at higher fluence!

Comparison all SiPMs: DCR vs G



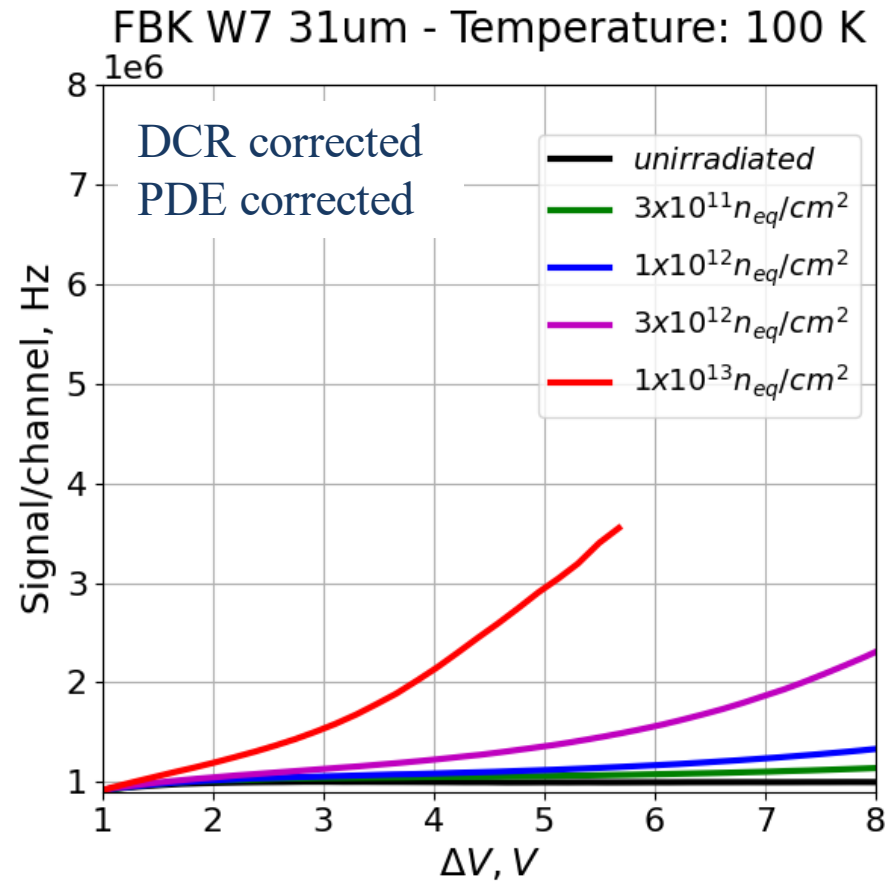
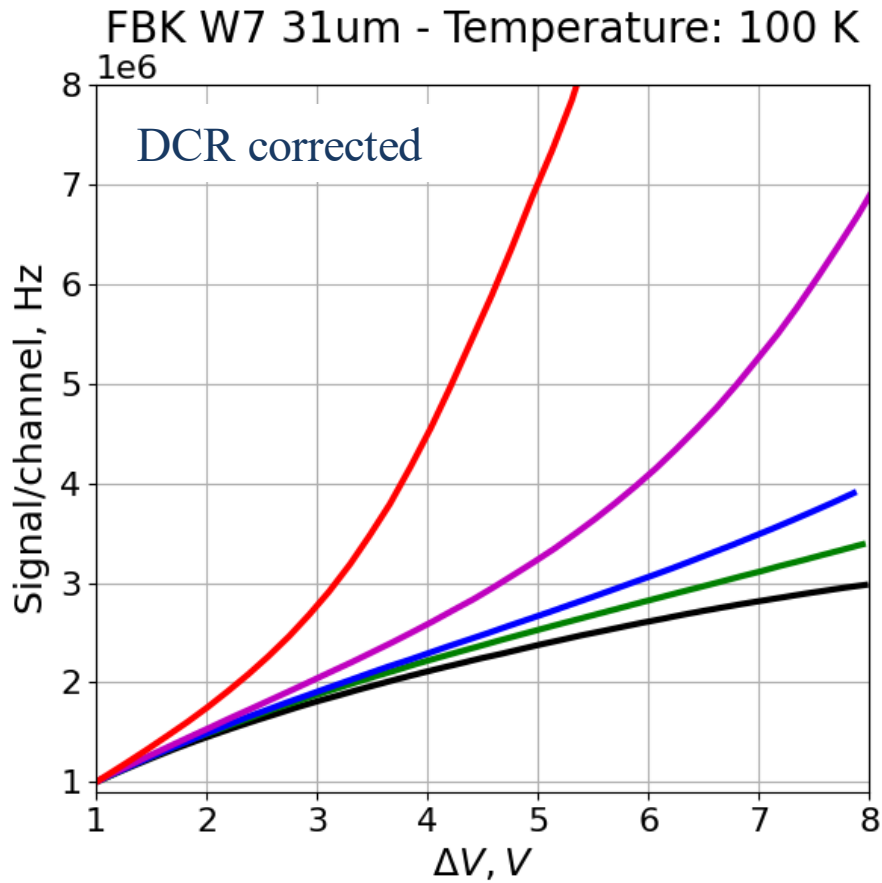
- Better performance of HPK when comparing DCR in terms of gain
- Similar performance of the FBK 42 μm and FBK 31 μm in terms of gain but, FBK 42 μm is better at higher gains
- Beside the difference in the Si wafers (FBK vs HPK), there are difference in the gain layer electric field in all devices

FBK SiPM 42 um: Signal vs ΔV at 100 K



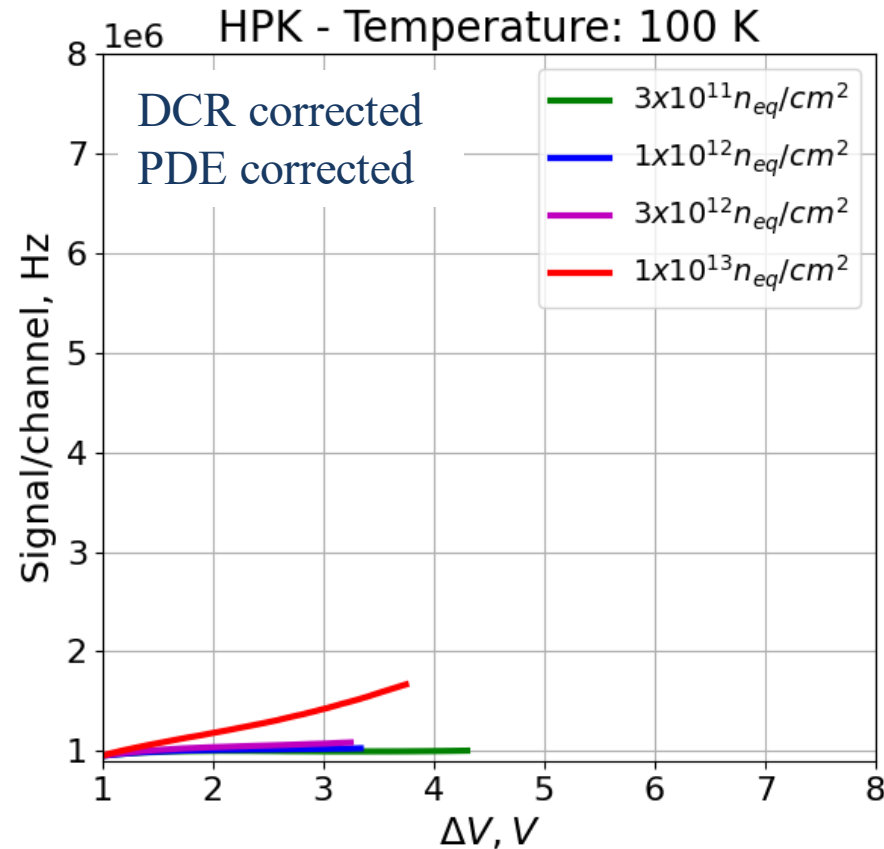
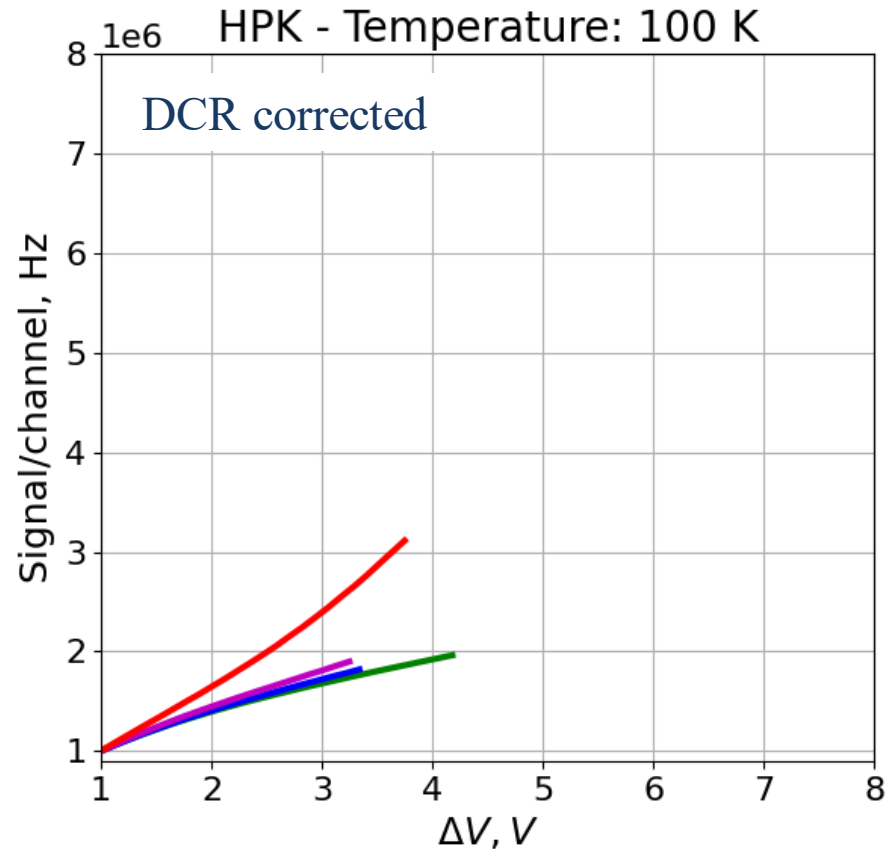
- Laser illumination (450 nm) to get a signal rate around 1 MHz/channel
 - › All data normalized to 1 MHz/channel for $\Delta V = 1V$.
- After DCR and PDE correction, it is observe an increase in the correlated noise for fluences higher that $1 \times 10^{12} n_{eq}/cm^2$.

FBK SiPM 31 um: Signal vs ΔV at 100 K



- Laser illumination (450 nm) to get a signal rate around 1 MHz/channel
 - › All data normalized to 1 MHz/channel for $\Delta V = 1V$
- After DCR and PDE correction, it is observe an increase in the correlated noise for fluences higher that $1 \times 10^{12} n_{eq}/cm^2$

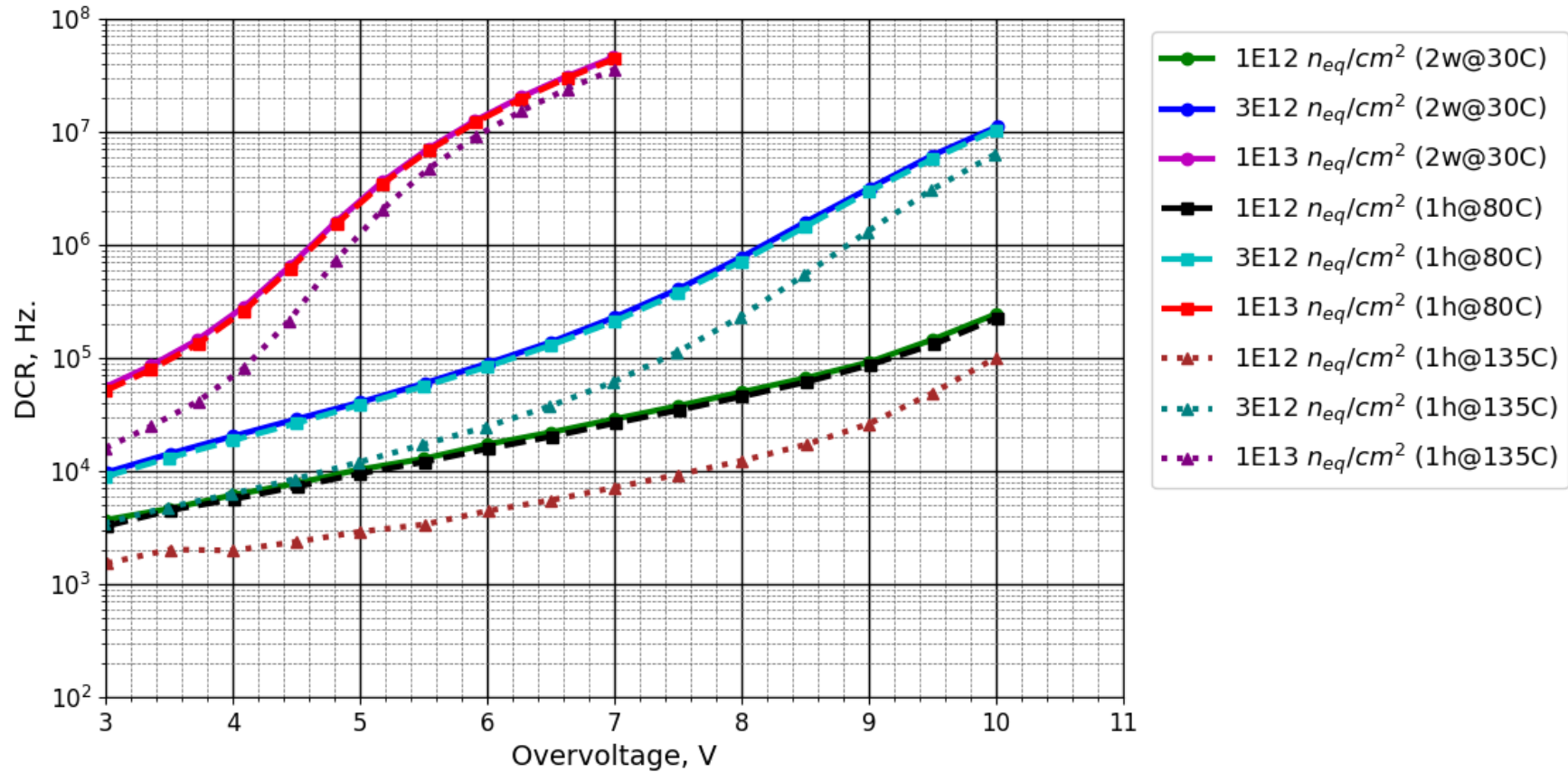
HPK SiPM: Signal vs ΔV at 100 K



- Laser illumination (450 nm) to get a signal rate around 1 MHz/channel
 - › All data normalized to 1 MHz/channel for $\Delta V = 1V$
- After DCR and PDE correction, it is observe an increase in the correlated noise for fluences higher that $3 \times 10^{12} n_{eq}/cm^2$

FBK SiPM 31 um: Annealing (measured at 100 K)

FBK_W7_31um: dark excess noise (100 K)



- Initial annealing after irradiation of 2weeks@30°C
- Further annealing at 80°C does not reduce the DCR further
- Only annealing at high temperature (135°C) is reducing DCR

Summary and conclusions:

- Breakdown voltage as a function of the temperature not linear (visible at cryogenic temperatures)
- R_q and T_r increase with cooling, a factor 6-7 from 300 K down to 100 K
- Gain slightly increases with cooling, direct crosstalk slightly decreases with cooling and PDE does not change
- DCR reduced by $\sim 10^3$ for operation (100 K and 4 V) compared to Upgrade I operation (210 K)
 - **This leads indeed to an almost noise free detector!**
- Large DCR increase beyond fluences of $\sim 1 \times 10^{12}$ n_{eq}/cm^2 and signal correlated noise increase beyond fluences of $\sim 3 \times 10^{12}$ n_{eq}/cm^2
- Small pixel size (low gain) and low ΔV (low gain) are better at high fluences
 - HPK SiPM modules less affected
 - The effect of the gain layer doping profile and wafer quality needs to be better understood
- Annealing at high temperatures ($> 80^\circ C$) helps to reduce DCR

Back up

SiPM modules irradiated at Ljubljana

Irradiated with **neutrons** in Ljubljana (summer 2023)

→ 3×10^{11} neq/cm², 1×10^{12} neq/cm², **3×10^{12} neq/cm²** and 1×10^{13} neq/cm²

After irradiation, an annealing of 2 weeks at 30°C was performed

		Number of detectors irradiated				Total
		Fluence				
Type	Wafer #	A 1.00E+13	B 3.00E+12	C (ref) 1.00E+12	D 3.00E+11	
16	1	0	0	0	0	0
	4	1	1	1	1	4
	7	0	0	0	0	0
	9	1	1	1	1	4
	11	0	0	0	0	0
31	1	1	1	2	1	5
	4	1	1	2	1	5
	7	1	1	2	1	5
	9	1	1	2	1	5
	11	1	1	2	1	5
31m	1	0	0	0	0	0
	4	1	1	1	1	4
	7	1	1	1	1	4
	9	1	1	1	1	4
	11	1	1	1	1	4
42	1	1	1	2	1	5
	4	1	1	2	1	5
	7	1	1	2	1	5
	9	1	1	2	1	5
	11	1	1	2	1	5
H2017		1	1	1	1	4
Total		17	17	27	17	78

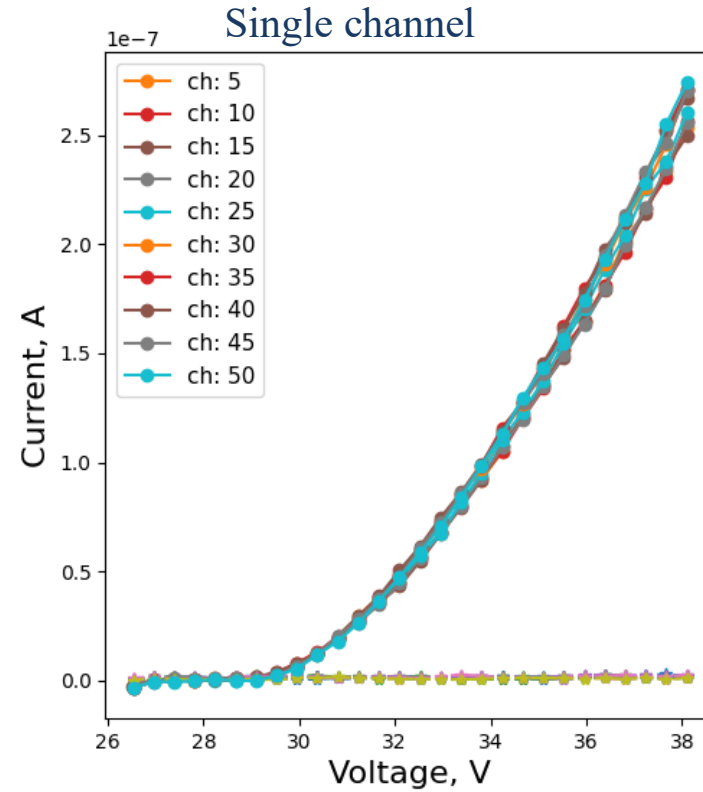
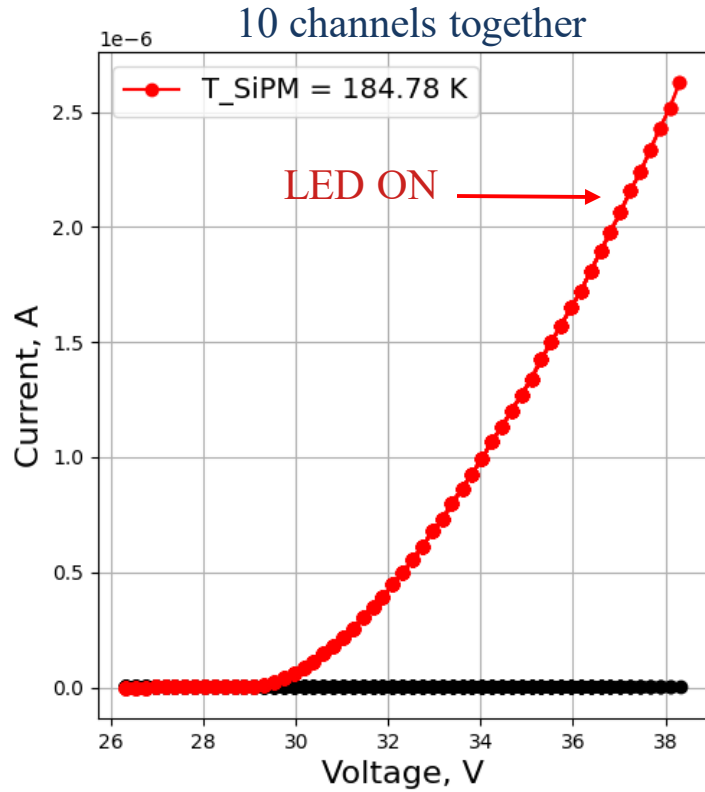
Detector #			
Fluence			
A 1.00E+13	B 3.00E+12	REF 1.00E+12	D 3.00E+11
#1	#2	#4	#5
#1	#2	#3	#5
#5	#6	#7, #8	#9
#1	#2	#3, #4	#5
#1	#2	#3, #4	#5
#1	#2	#4, #5	#6
#1	#2	#3, #5	#6
#1	#2	#3	#4
#1	#2	#5	#6
#2	#3	#4	#5
#1	#2	#3	#4
#2	#3	#5, #6	#8
#2	#3	#6, #8	#9
#1	#2	#3, #5	#6
#1	#2	#3., #4	#5
#1	#2	#3., #4	#5
#169	#205	#563	#1149

One set of H2017 SiPM modules were also included as a reference

Measurement campaign: V_{bd}

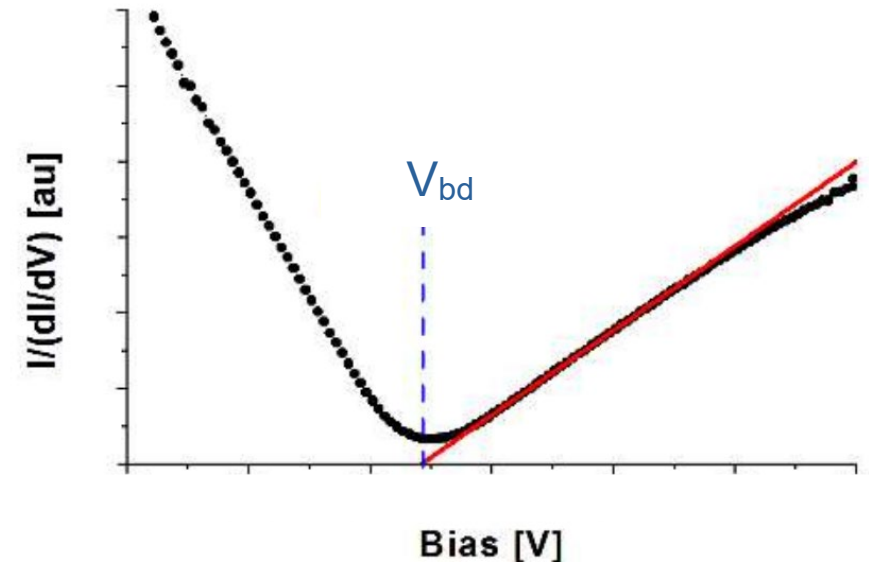
Extracting the breakdown voltage

E.g.: FBK_W4_42um (unirradiated)



Method of Inverse Logarithmic Derivative (ILD)

$$ILD = \left(\frac{d \ln[I(V)]}{dV} \right)^{-1} \equiv \left[\frac{1}{I} \cdot \frac{dI(V)}{dV} \right]^{-1}$$

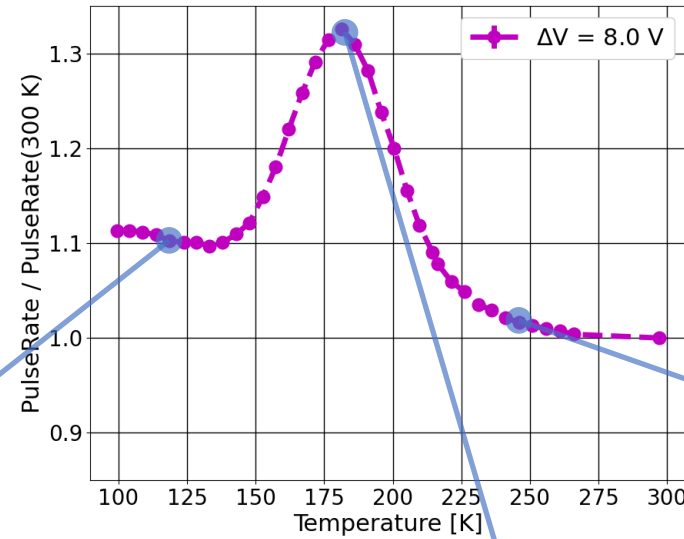


Detector:
FBK_W3_42um_003_Flat

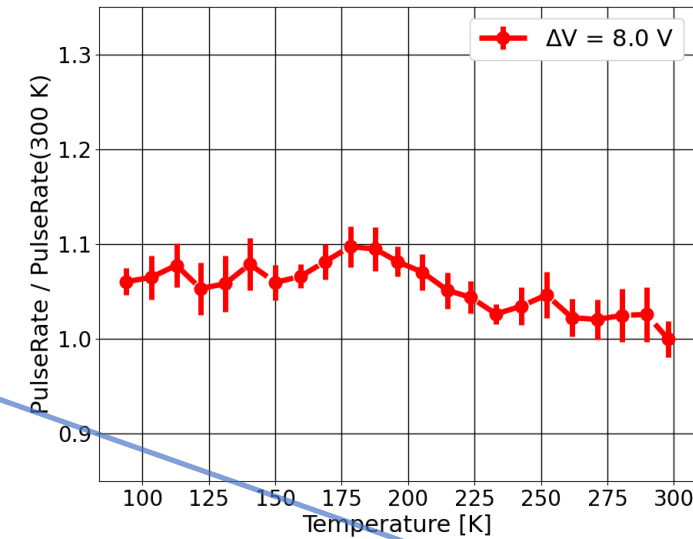
Laser CH81:

- Intensity set for 1 pe.
- Wavelength: 450 nm
- Laser rate: 500 KHz
- **Over-voltage: 8.0 V**
- 1 pe amplitude: 260 mV
- Threshold for AP: 130 mV
- Excluded all peaks with amplitude higher than 1 pe.

Illumination: Monochromator ($\lambda = 450$ nm)



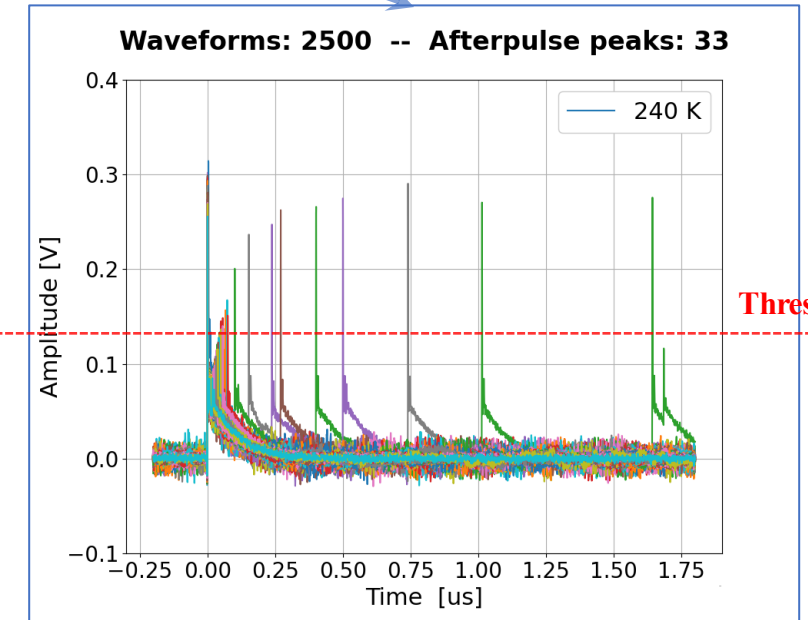
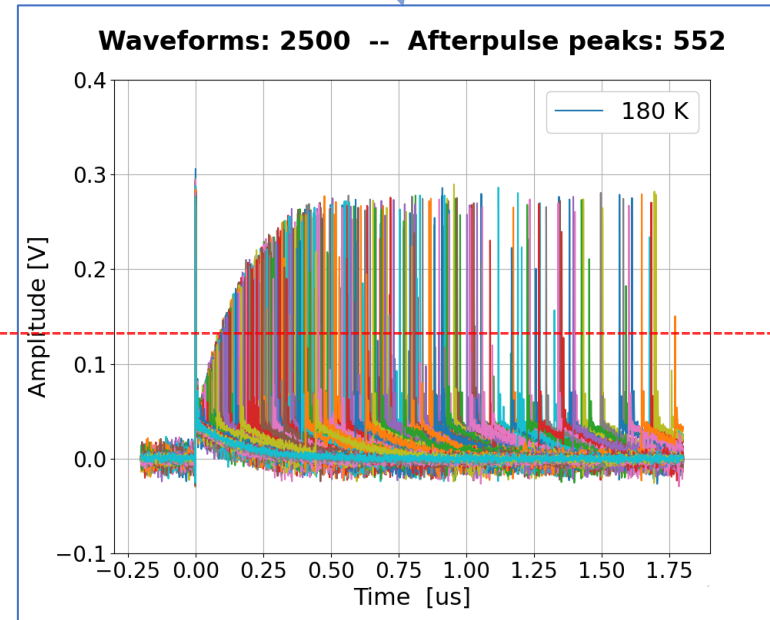
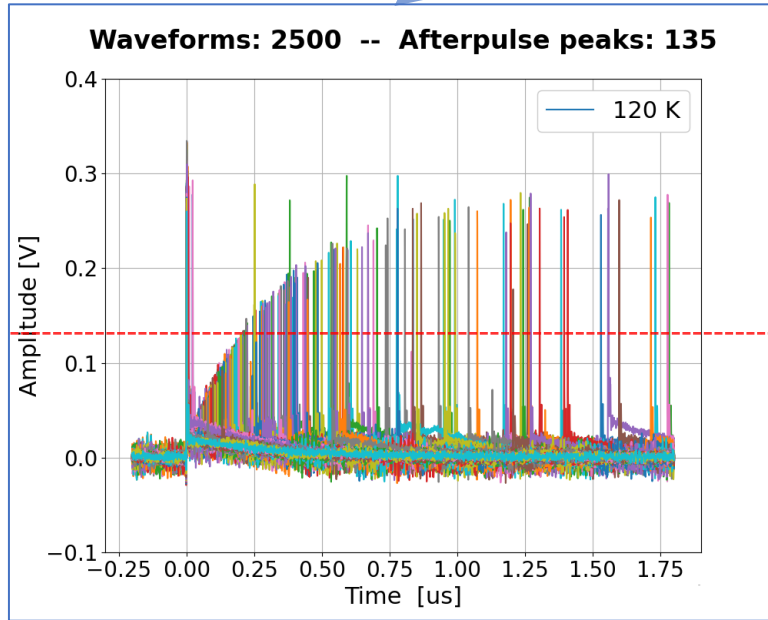
Illumination: Laser ($\lambda = 450$ nm)



AP = 5.4%

AP = 22.1%

AP = 1.3%

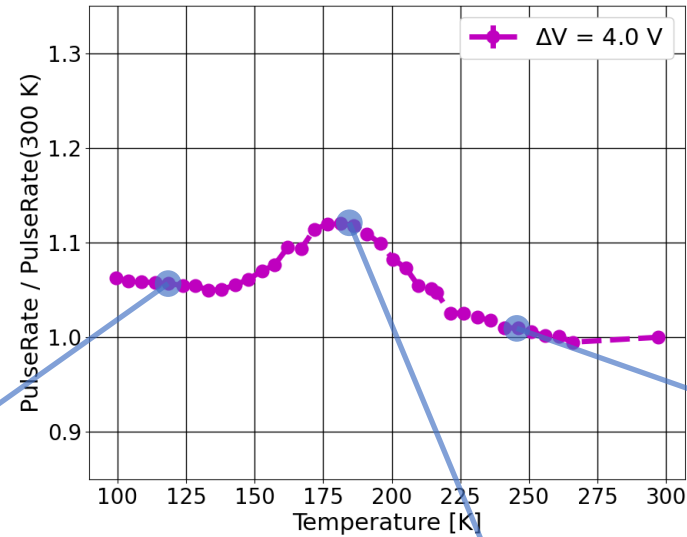


Detector: FBK_W3_42um_003_Flat

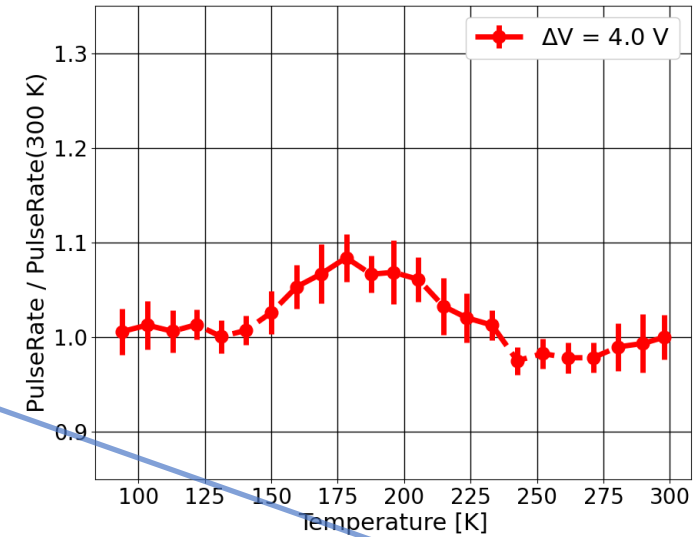
Laser CH81:

- Intensity set for 1 pe.
- Wavelength: 450 nm
- Laser rate: 500 KHz
- **Over-voltage: 4.0 V**
- 1 pe amplitude: 130 mV
- Threshold for AP: 65 mV
- Excluded all peaks with amplitude higher than 1 pe.

Illumination: Monochromator ($\lambda = 450 \text{ nm}$)



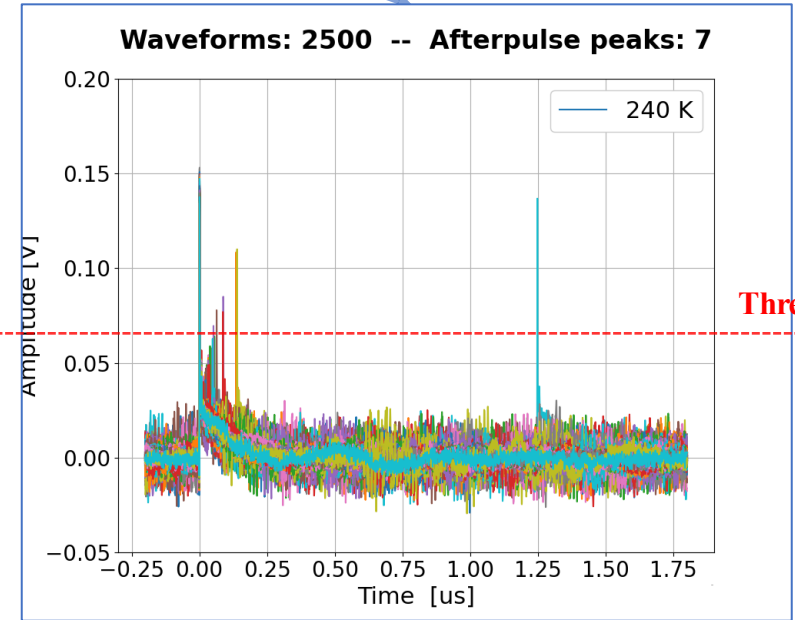
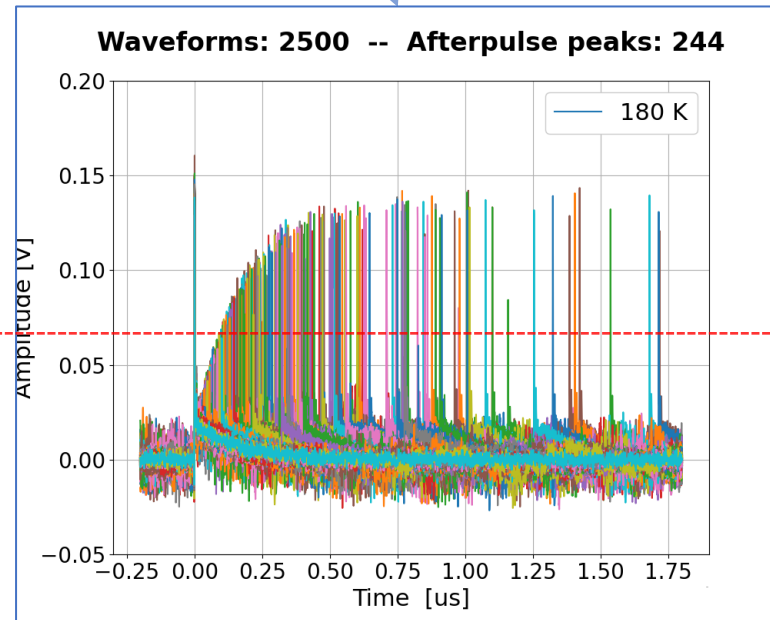
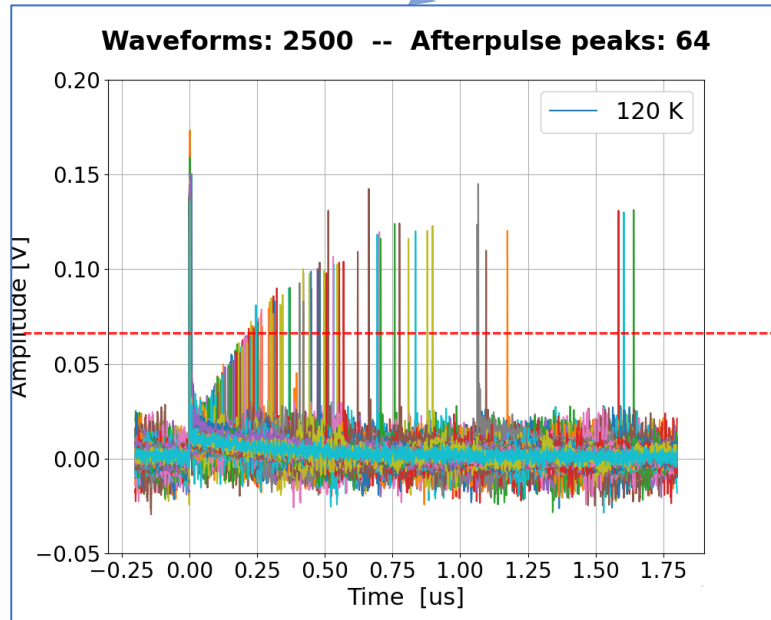
Illumination: Laser ($\lambda = 450 \text{ nm}$)



AP = 2.6%

AP = 9.8%

AP = 0.3%



Threshold